

# DSC-H2

## SERVICE MANUAL

**LEVEL 3**

**Ver. 1.3 2006.10**

**Revision History**

**How to use  
Acrobat Reader**

**Internal memory  
ON BOARD**



*US Model  
Canadian Model  
AEP Model  
UK Model  
E Model  
Australian Model  
Chinese Model  
Argentina Model  
Hong Kong Model  
Korea Model  
Tourist Model*

### Link

<a href="#">SERVICE NOTE</a>	<a href="#">PRINTED WIRING BOARDS</a>
<a href="#">SCHEMATIC DIAGRAMS</a>	<a href="#">REPAIR PARTS LIST</a>

**Note :**

The components identified by mark  $\triangle$  or dotted line with mark  $\triangle$  are critical for safety. Replace only with part number specified.

**Note :**

Les composants identifiés par une marque  $\triangle$  sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

**DIGITAL STILL CAMERA**

**SONY®**

## SAFETY CHECK-OUT

After correcting the original service problem, perform the following safety checks before releasing the set to the customer.

1. Check the area of your repair for unsoldered or poorly-soldered connections. Check the entire board surface for solder splashes and bridges.
2. Check the interboard wiring to ensure that no wires are "pinched" or contact high-wattage resistors.
3. Look for unauthorized replacement parts, particularly transistors, that were installed during a previous repair. Point them out to the customer and recommend their replacement.
4. Look for parts which, through functioning, show obvious signs of deterioration. Point them out to the customer and recommend their replacement.
5. Check the B+ voltage to see it is at the values specified.
6. Flexible Circuit Board Repairing
  - Keep the temperature of the soldering iron around 270°C during repairing.
  - Do not touch the soldering iron on the same conductor of the circuit board (within 3 times).
  - Be careful not to apply force on the conductor when soldering or unsoldering.

### Unleaded solder

Boards requiring use of unleaded solder are printed with the lead-free mark (LF) indicating the solder contains no lead. (Caution: Some printed circuit boards may not come printed with the lead free mark due to their particular size.)



### LF : LEAD FREE MARK

Unleaded solder has the following characteristics.

- Unleaded solder melts at a temperature about 40°C higher than ordinary solder.  
Ordinary soldering irons can be used but the iron tip has to be applied to the solder joint for a slightly longer time.  
Soldering irons using a temperature regulator should be set to about 350°C.  
Caution: The printed pattern (copper foil) may peel away if the heated tip is applied for too long, so be careful!
- Strong viscosity  
Unleaded solder is more viscous (sticky, less prone to flow) than ordinary solder so use caution not to let solder bridges occur such as on IC pins, etc.
- Usable with ordinary solder  
It is best to use only unleaded solder but unleaded solder may also be added to ordinary solder.

### SAFETY-RELATED COMPONENT WARNING!!

COMPONENTS IDENTIFIED BY MARK  $\triangle$  OR DOTTED LINE WITH MARK  $\triangle$  ON THE SCHEMATIC DIAGRAMS AND IN THE PARTS LIST ARE CRITICAL TO SAFE OPERATION. REPLACE THESE COMPONENTS WITH SONY PARTS WHOSE PART NUMBERS APPEAR AS SHOWN IN THIS MANUAL OR IN SUPPLEMENTS PUBLISHED BY SONY.

### ATTENTION AU COMPOSANT AYANT RAPPORT À LA SÉCURITÉ!

LES COMPOSANTS IDENTIFIÉS PAR UNE MARQUE  $\triangle$  SUR LES DIAGRAMMES SCHÉMATIQUES ET LA LISTE DES PIÈCES SONT CRITIQUES POUR LA SÉCURITÉ DE FONCTIONNEMENT. NE REMPLACER CES COMPOSANTS QUE PAR DES PIÈCES SONY DONT LES NUMÉROS SONT DONNÉS DANS CE MANUEL OU DANS LES SUPPLÉMENTS PUBLIÉS PAR SONY.

#### CAUTION :

Danger of explosion if battery is incorrectly replaced.  
Replace only with the same or equivalent type.

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# 1. SERVICE NOTE

## 1-1. METHOD FOR COPYING OR ERASING THE DATA IN INTERNAL MEMORY

The data can be copied/erased by the operations on the Setup screen. (When erasing the data, execute formatting the internal memory.)

**Note: 1** When replacing the SY-150 board, erase the data in internal memory of the board before replacement.

**Note: 2** When replacing the SY-150 board or the IC202 on the SY-150 board, execute formatting and initialize the internal memory after replacement.

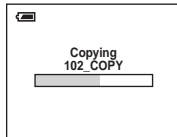
### Method for Copying the Data in Internal Memory

#### Copy

Copies all images in the internal memory to a "Memory Stick".


<input type="checkbox"/>	OK	See the following procedure.
<input checked="" type="checkbox"/>	Cancel	Cancels the copying.

- ① Insert a "Memory Stick" having 32 MB or larger capacity.
- ② Select [OK] with ▲ on the control button, then press ●.  
The message "All data in internal memory will be copied Ready?" appears.
- ③ Select [OK] with ▲, then press ●.  
Copying starts.




Use batteries with enough capacity or the AC Adaptor (not supplied). If you attempt to copy image files using batteries with little remaining capacity, the batteries may run out, causing copying to fail or possibly corrupting the data.

You cannot copy individual images.

The original images in the internal memory are retained even after copying. To delete the contents of the internal memory, remove the "Memory Stick" after copying, then execute the [Format] command in  Internal Memory Tool.

You cannot select a folder copied on a "Memory Stick".

The setting of  (Print order) marks is not copied even when you copy data.

### Method for Formatting the Internal Memory

#### Format

Formats the internal memory.

Note that formatting irrevocably erases all data in the internal memory, including even protected images.

<input type="checkbox"/>	OK	See the following procedure.
<input checked="" type="checkbox"/>	Cancel	Cancels the formatting.

- ① Select [OK] with ▲ on the control button, then press ●.  
The message "All data in internal memory will be erased Ready?" appears.
- ② Select [OK] with ▲, then press ●.  
The format is complete.

## • PROCESS AFTER FIXING FLASH ERROR

When "FLASH error" (Self-diagnosis Code E : 91 : \*\* ) occurs, to prevent any abnormal situation caused by high voltage, setting of the flash is changed automatically to disabling charge and flash setting.

After fixing, this setting needs to be deactivated. Flash error code can be initialized by the operations on the Setup screen.

### Method for Initializing the Flash Error Code

#### Initialize

Initializes the setting to the default setting.

<input type="checkbox"/>	OK	See the following procedure.
<input checked="" type="checkbox"/>	Cancel	Cancels the resetting.

- ① Select [OK] with ▲ on the control button, then press ●.  
The message "Initialize all settings Ready?" appears.
- ② Select [OK] with ▲, then press ●.  
The settings are reset to the default setting.  
Make sure that the power is not disconnected during resetting.

## 4-2. SCHEMATIC DIAGRAMS

### Link

<ul style="list-style-type: none"><li>• SY-150 BOARD (1/8) (LENS DRIVE)</li></ul>	<ul style="list-style-type: none"><li>• SY-150 BOARD (6/8) (STEADY SHOT CONTROL)</li></ul>
<ul style="list-style-type: none"><li>• SY-150 BOARD (2/8) (CAMERA A/D CONV., TIMING GENERATOR)</li></ul>	<ul style="list-style-type: none"><li>• SY-150 BOARD (7/8) (CONNECTOR)</li></ul>
<ul style="list-style-type: none"><li>• SY-150 BOARD (3/8) (CAMERA DSP, SYSTEM CONTROL)</li></ul>	<ul style="list-style-type: none"><li>• SY-150 BOARD (8/8) (DC/DC CONVERTER)</li></ul>
<ul style="list-style-type: none"><li>• SY-150 BOARD (4/8) (256Mbit SDRAM, FLASH MEMORY, One NAND)</li></ul>	<ul style="list-style-type: none"><li>• CH-169 BOARD (CCD SIGNAL PROCESS)</li></ul>
<ul style="list-style-type: none"><li>• SY-150 BOARD (5/8) (A/V AMP, A/V, USB JACK RELAY)</li></ul>	

- COMMON NOTE FOR SCHEMATIC DIAGRAMS

## 4-2. SCHEMATIC DIAGRAMS

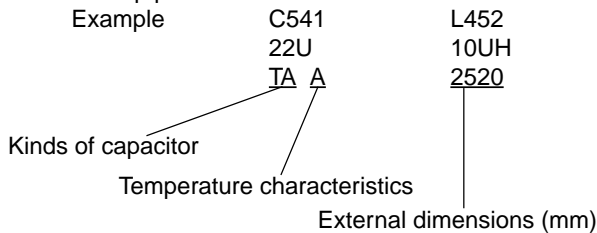
### 4-2. SCHEMATIC DIAGRAMS

**THIS NOTE IS COMMON FOR SCHEMATIC DIAGRAMS**

(In addition to this, the necessary note is printed in each block)

**(For schematic diagrams)**

- All capacitors are in  $\mu\text{F}$  unless otherwise noted.  $\text{pF}$  :  $\mu\text{F}$ . 50 V or less are not indicated except for electrolytics and tantalums.
- Chip resistors are 1/10 W unless otherwise noted.  $\text{k}\Omega=1000 \Omega$ ,  $\text{M}\Omega=1000 \text{k}\Omega$ .
- Caution when replacing chip parts. New parts must be attached after removal of chip. Be careful not to heat the minus side of tantalum capacitor, Because it is damaged by the heat.
- Some chip part will be indicated as follows.



- Constants of resistors, capacitors, ICs and etc with XX indicate that they are not used. In such cases, the unused circuits may be indicated.
- Parts with \* differ according to the model/destination. Refer to the mount table for each function.
- All variable and adjustable resistors have characteristic curve B, unless otherwise noted.
- Signal name  
 $\text{XEDIT} \rightarrow \overline{\text{EDIT}}$        $\text{PB/XREC} \rightarrow \overline{\text{PB/REC}}$
- : non flammable resistor
- : fusible resistor
- : panel designation
- : B+ Line
- : B- Line
- : IN/OUT direction of (+,-) B LINE.
- : adjustment for repair.

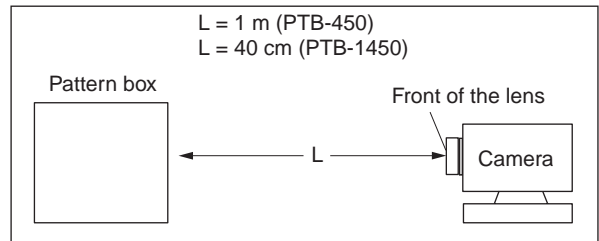
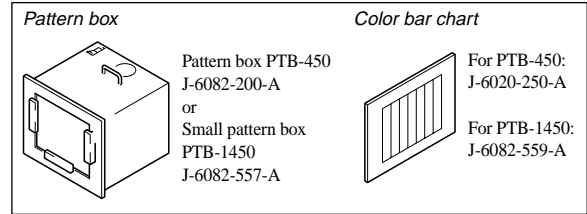
**(Measuring conditions voltage)**

- Voltages are measured between the measurement points and ground when camera shoots color bar chart of pattern box. They are reference values. (VOM of DC 10  $\text{M}\Omega$  input impedance is used)
- Voltage values change depending upon input impedance of VOM used.)

**Precautions for Replacement of imager**

- If the imager has been replaced, carry out all the adjustments for the camera section.
- As the imager may be damaged by static electricity from its structure, handle it carefully like for the MOS IC. In addition, ensure that the receiver is not covered with dusts nor exposed to strong light.

**1. Connection**



**2. Adjust the distance so that the output waveform of Fig. a and the Fig. b can be obtain.**

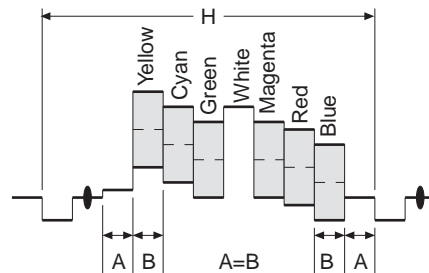


Fig. a (Video output terminal output waveform)

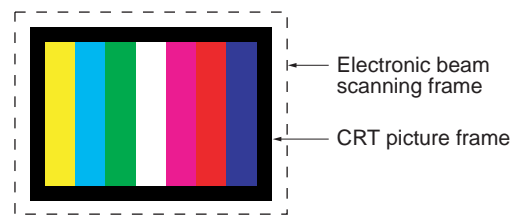


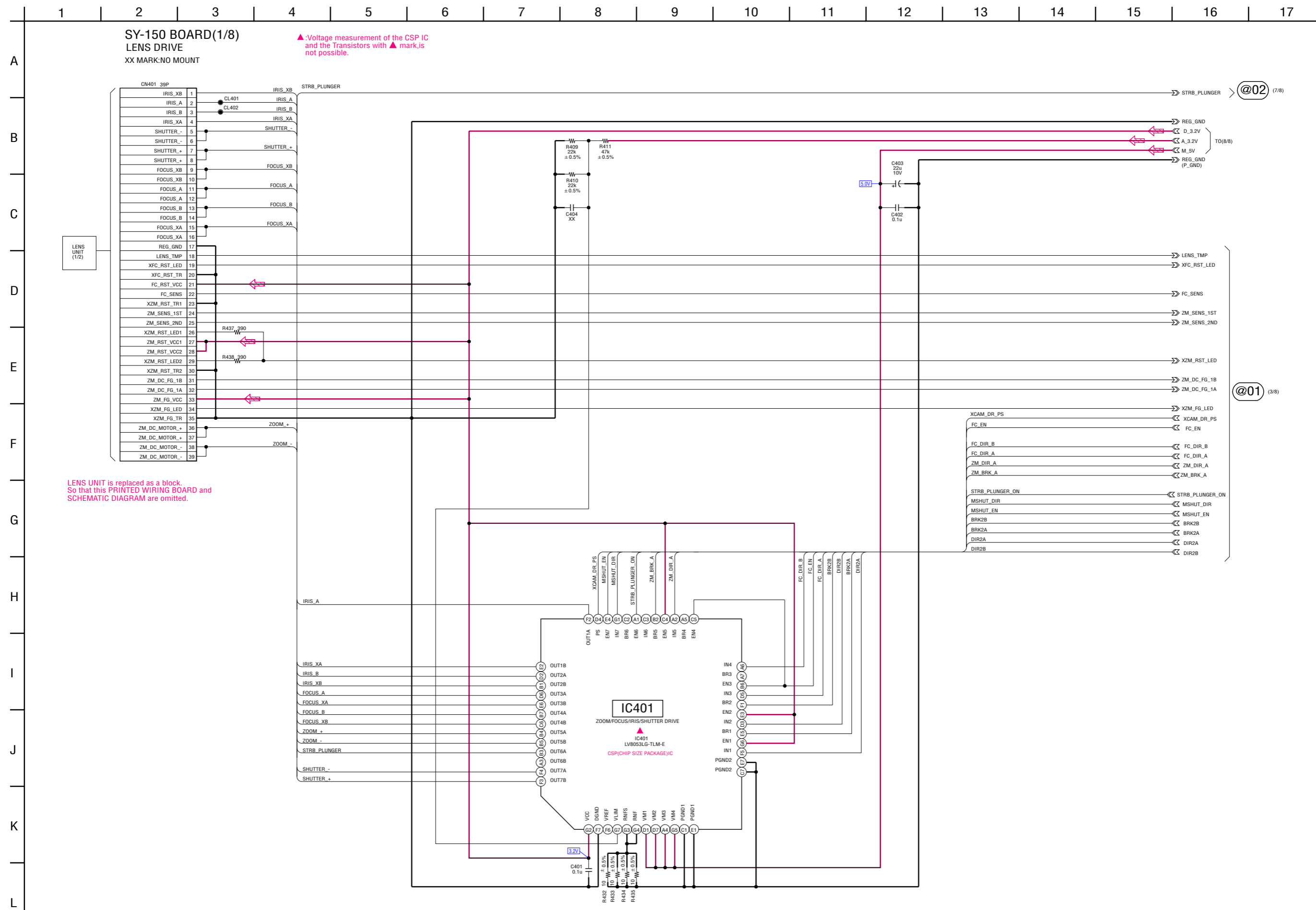
Fig. b (Picture on monitor TV)

When indicating parts by reference number, please include the board name.

**Note :**  
The components identified by mark  $\Delta$  or dotted line with mark  $\Delta$  are critical for safety. Replace only with part number specified.

**Note :**  
Les composants identifiés par une marque  $\Delta$  sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

# 4-2. SCHEMATIC DIAGRAMS



LENS UNIT is replaced as a block.  
So that this PRINTED WIRING BOARD and  
SCHEMATIC DIAGRAM are omitted.

▲:Voltage measurement of the CSP IC  
and the Transistors with ▲ mark, is  
not possible.

@02 (7/8)

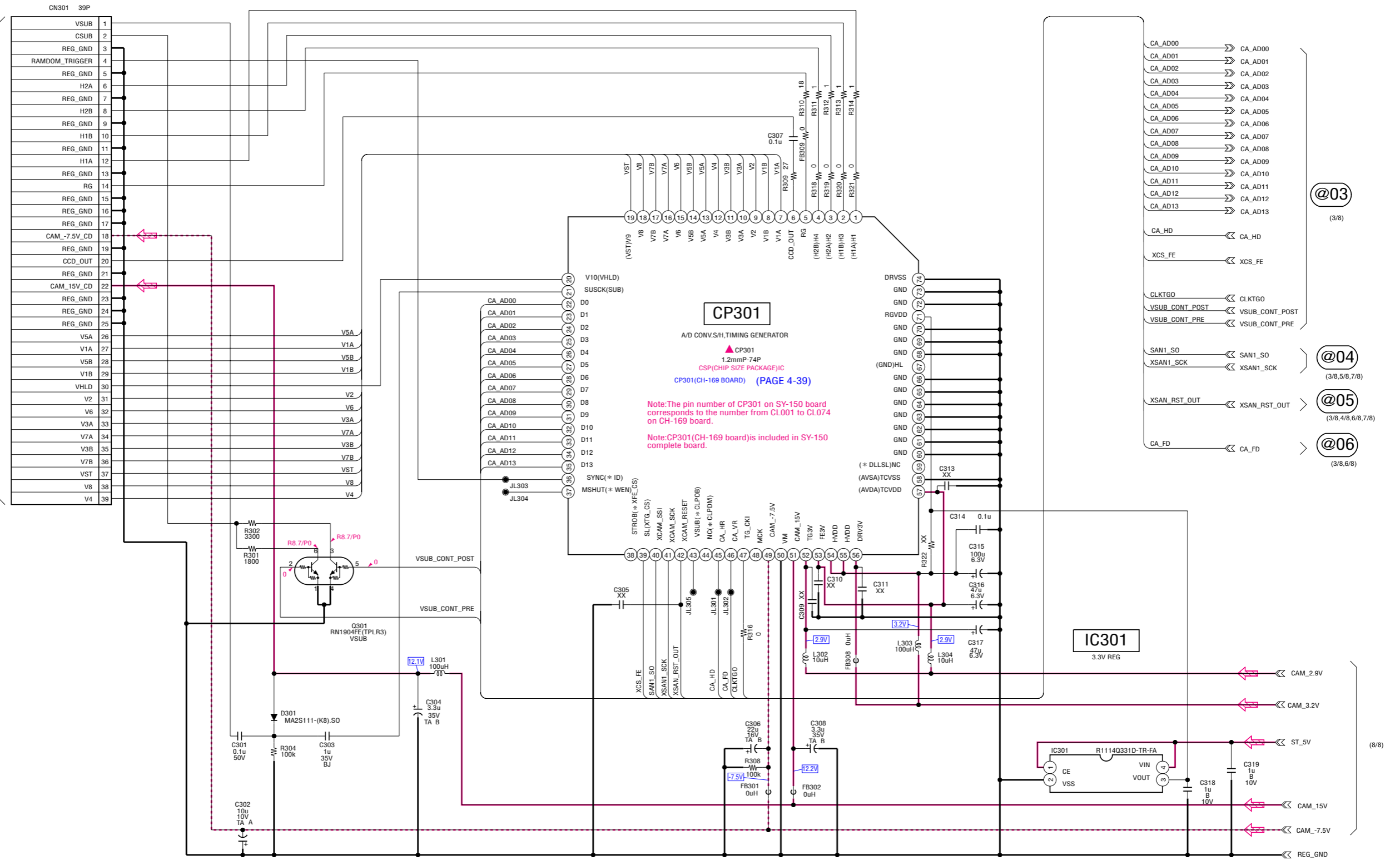
@01 (3/8)

**SY-150 BOARD(2/8)**  
CAMERA A/D CONV.TIMING GENERATOR  
XX MARK:NO MOUNT

▲ :Voltage measurement of the CSP IC and the Transistors with ▲ mark,is not possible.

NO MARK:REC/PB MODE  
R :REC MODE  
P :PB MODE

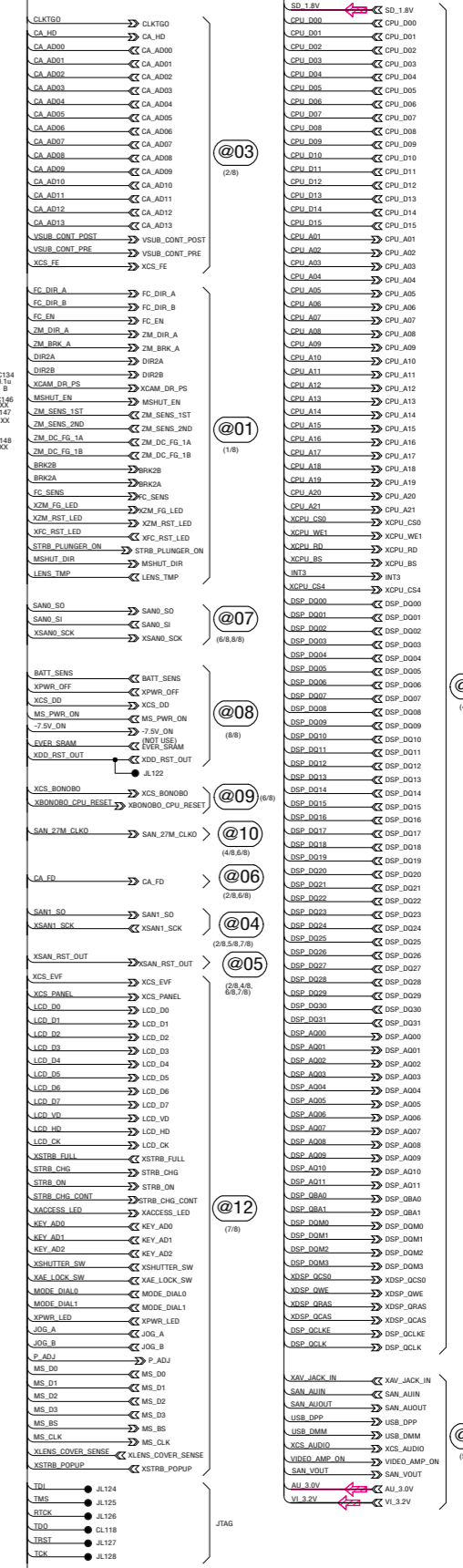
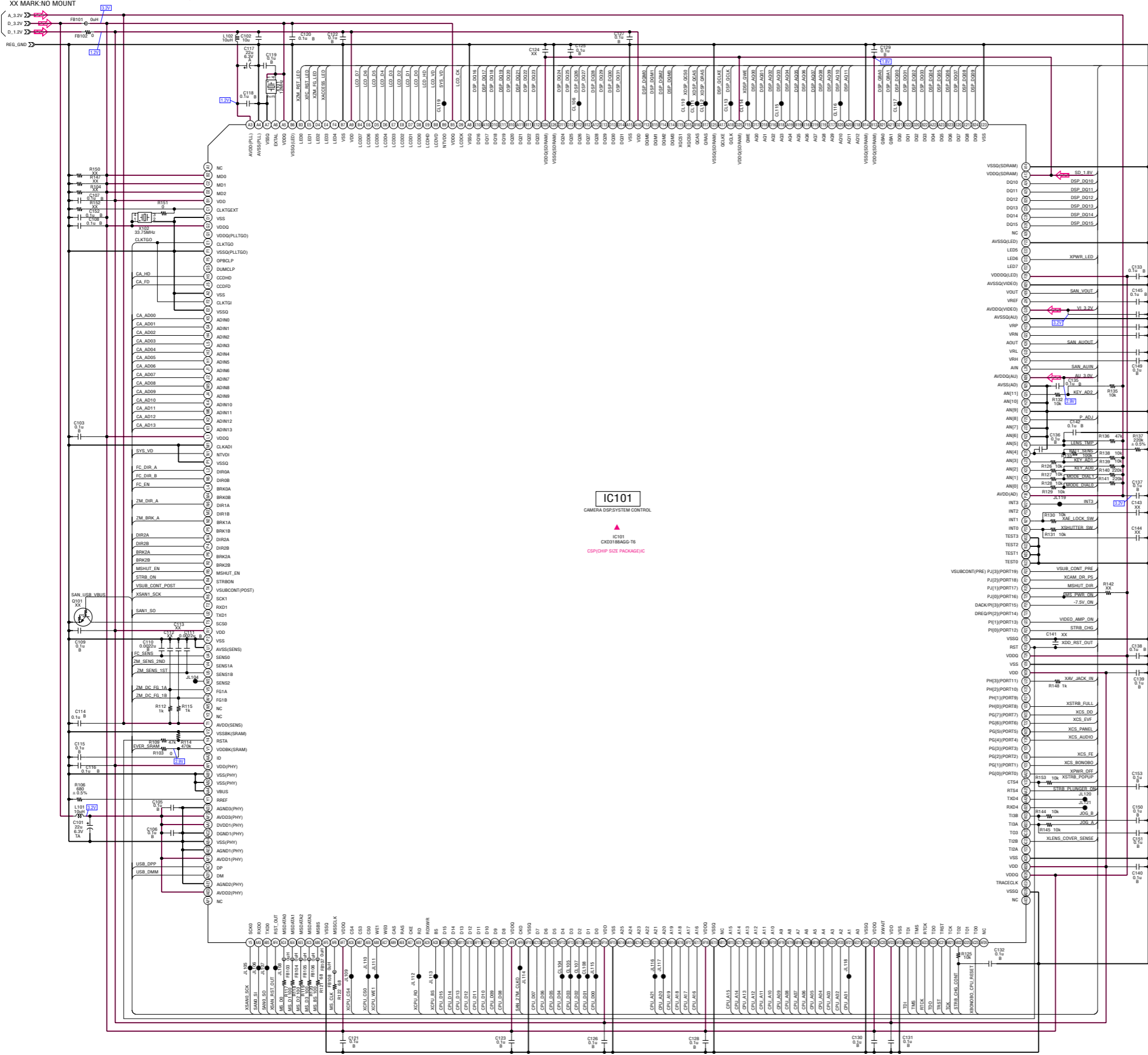
TO CD-621 FLEXIBLE BOARD (PAGE 4-19 of LEVEL 2)

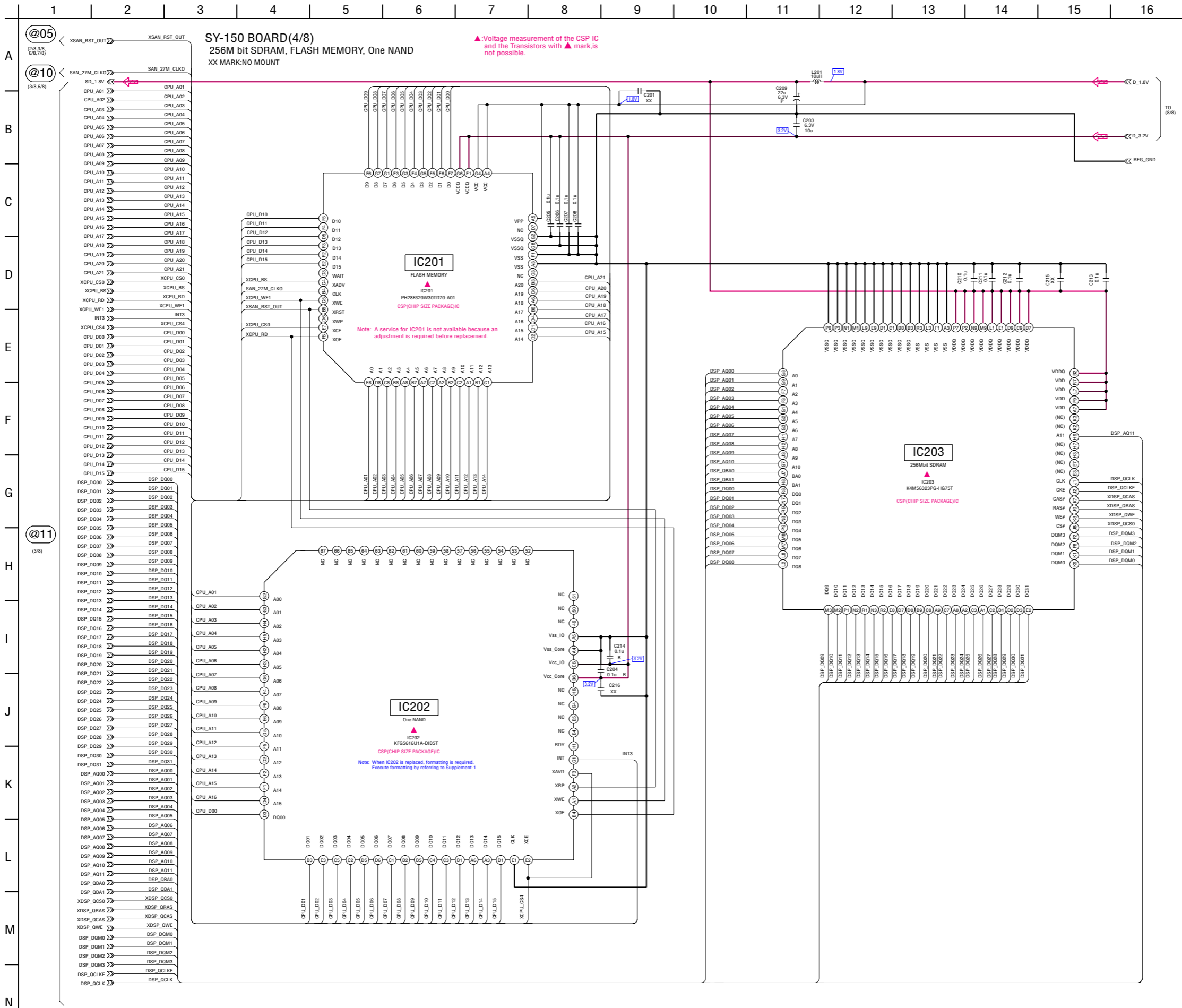




SY-150 BOARD(3/8)  
CAMERA DSP SYSTEM CONTROL  
XX MARK: NO MOUNT

▲ Voltage measurement of the CSP IC and the Transistors with ▲ mark, is not possible.

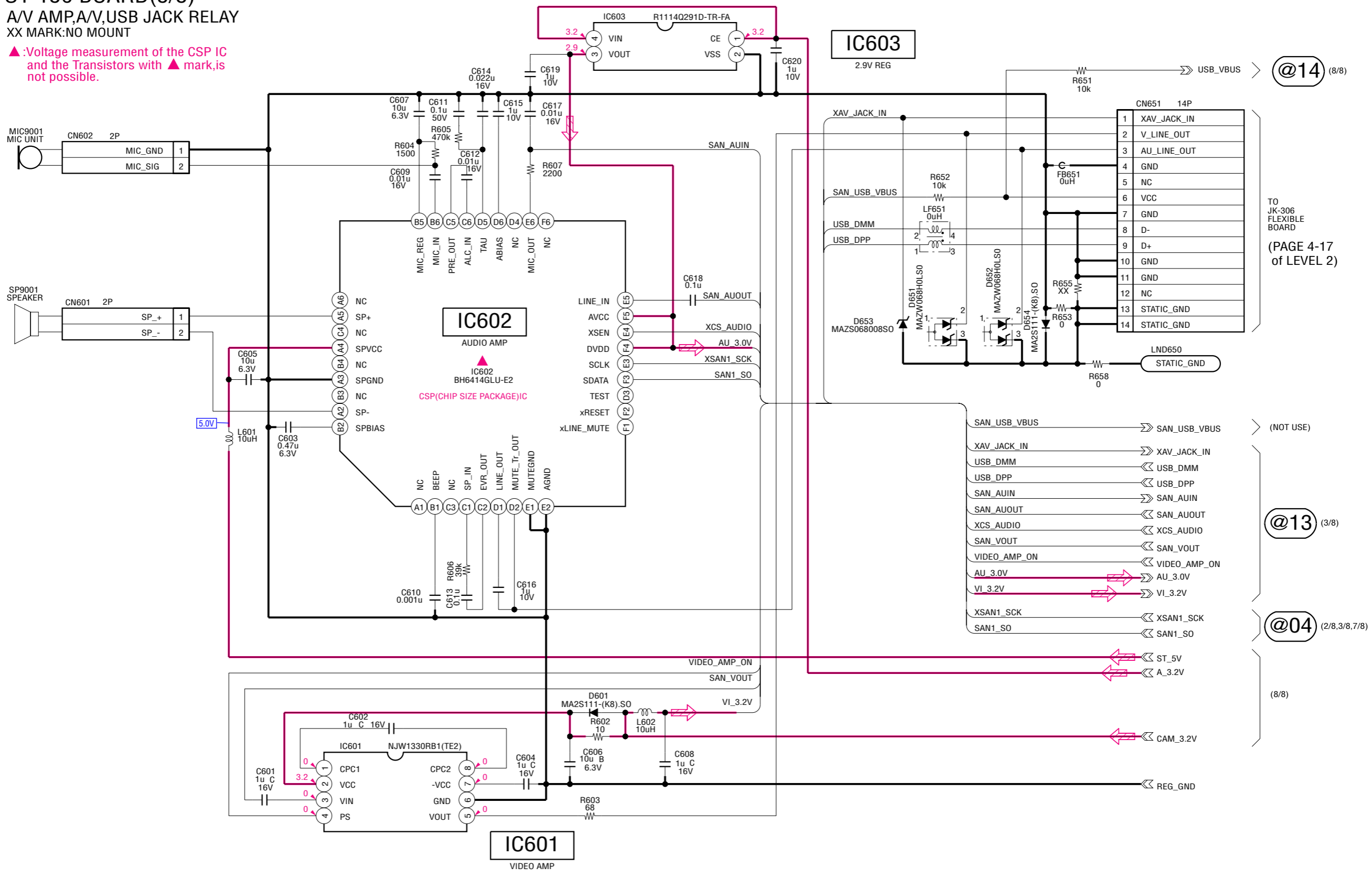




**SY-150 BOARD(5/8)**  
**A/V AMP,A/V,USB JACK RELAY**  
 XX MARK:NO MOUNT

▲:Voltage measurement of the CSP IC and the Transistors with ▲ mark,is not possible.

A  
B  
C  
D  
E  
F  
G



@14 (8/8)

TO JK-306 FLEXIBLE BOARD (PAGE 4-17 of LEVEL 2)

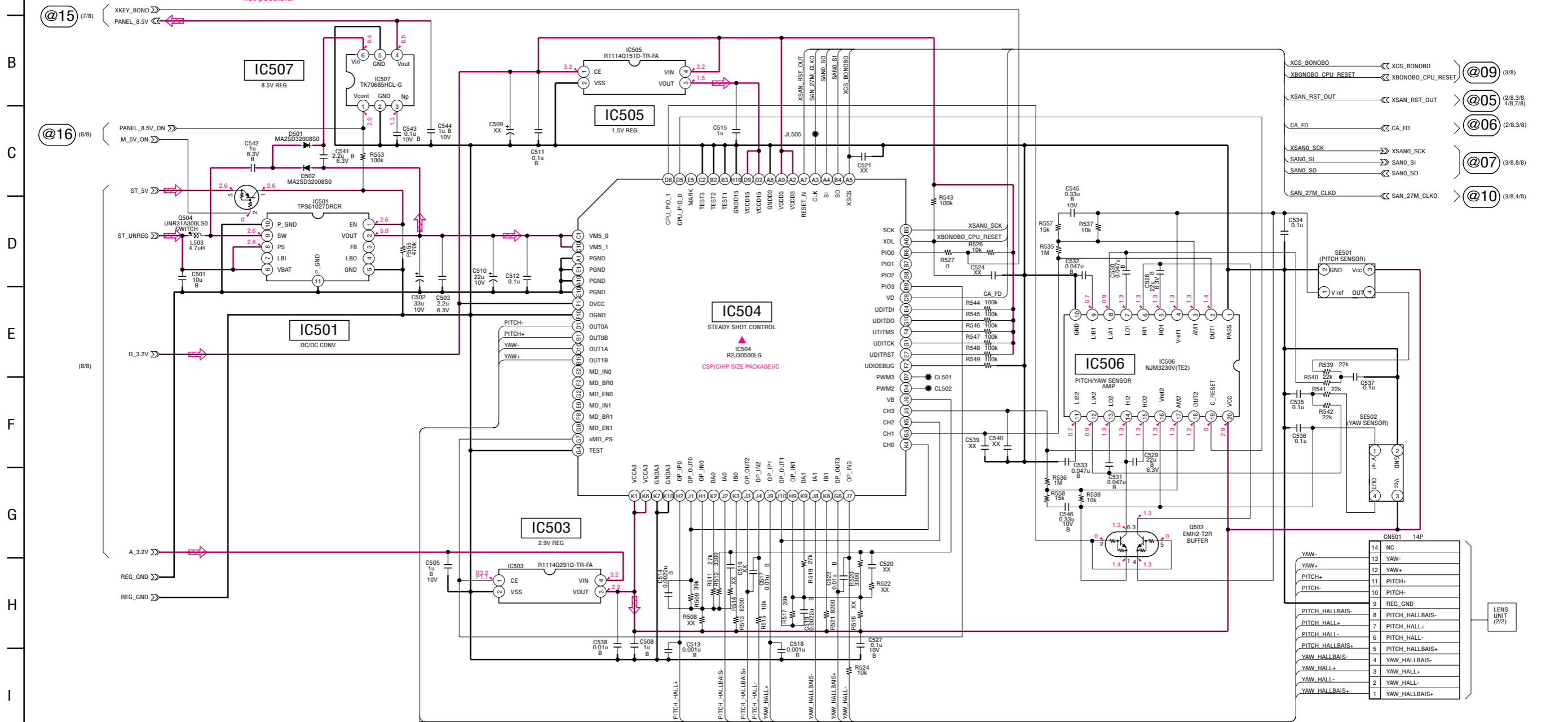
@13 (3/8)

@04 (2/8,3/8,7/8)

(8/8)

**SY-150 BOARD(6/8)**  
**STEADY SHOT CONTROL**  
 XX MARK:NO MOUNT

NO MARK-REC/PB MODE  
 R :REC MODE  
 P :PB MODE  
 ▲:Voltage measurement of the CSP IC and the Transistors with ▲ mark,is not possible.



LENS UNIT is replaced as a block.  
 So that this PRINTED WIRING BOARD and SCHEMATIC DIAGRAM are omitted.

A  
B  
C  
D  
E  
F  
G  
H  
I

**SY-150 BOARD(7/8)**

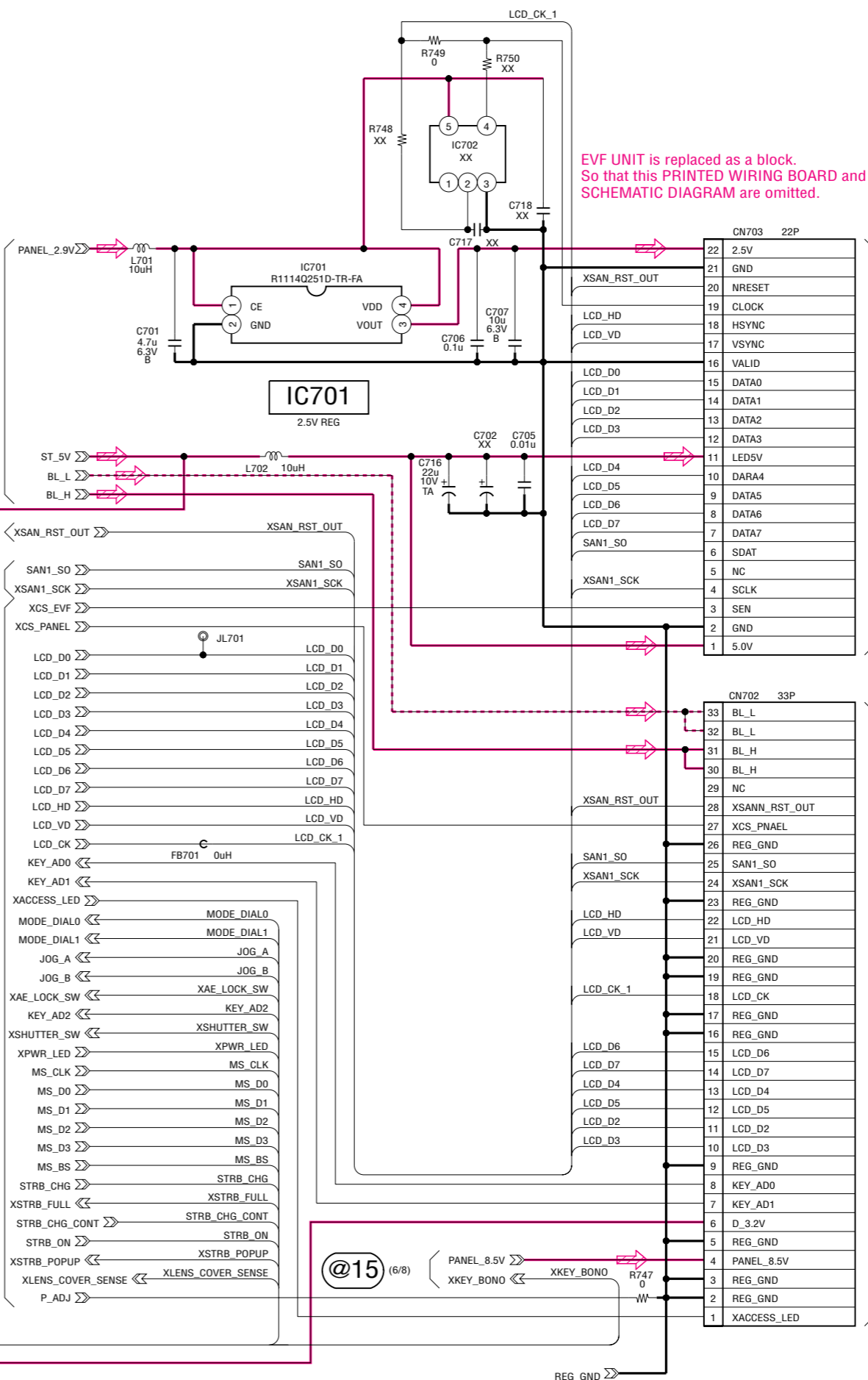
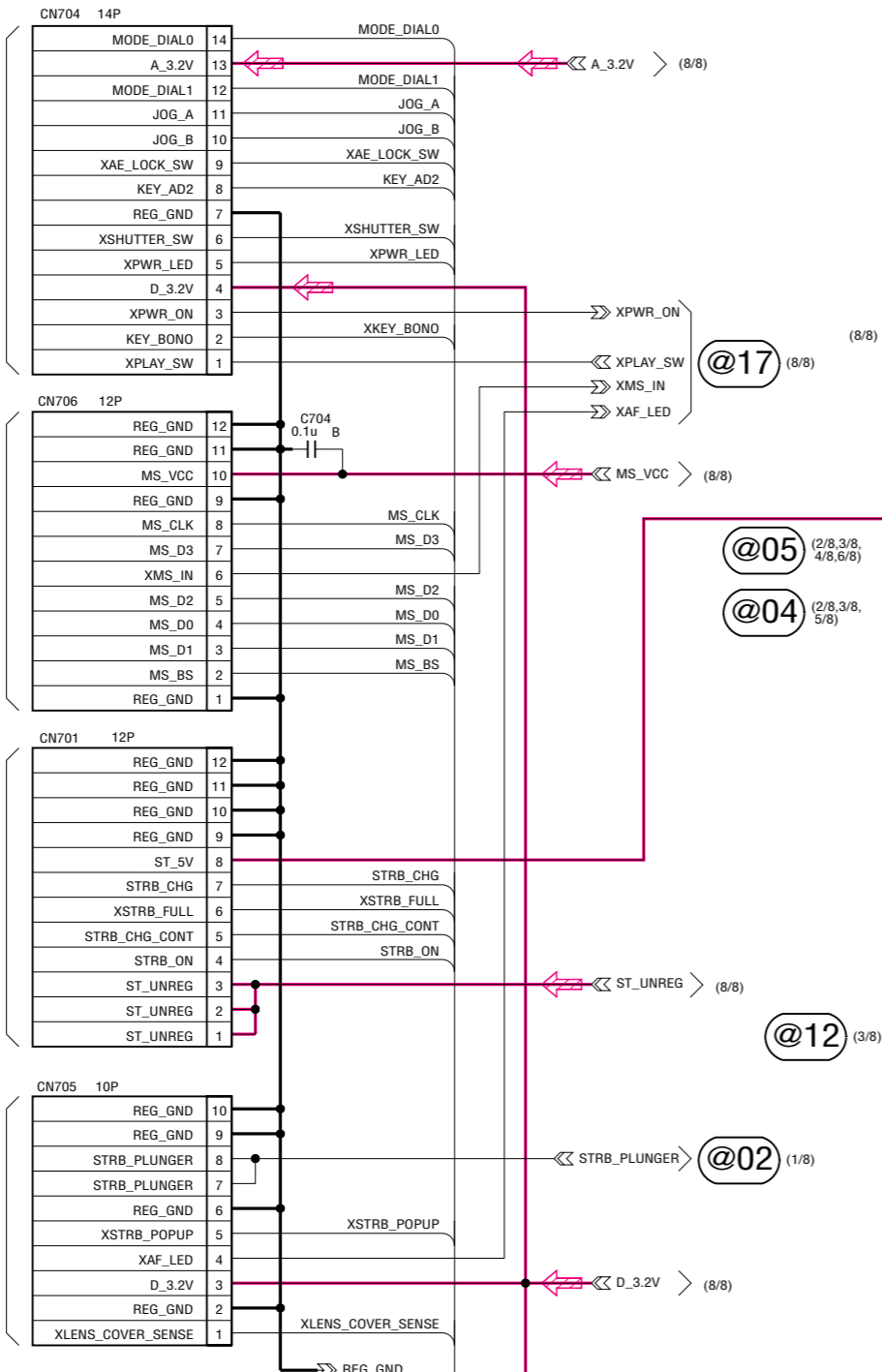
**CONNECTOR**  
XX MARK:NO MOUNT

TO CONTROL SWITCH BLOCK (MODE DIAL) (PAGE 4-15 of LEVEL 2)

TO MS-030 FLEXIBLE FLAT CABLE (PAGE 4-21 of LEVEL 2)

TO ST-003 FLEXIBLE FLAT CABLE (PAGE 4-22 of LEVEL 2)

TO AF-105 FLEXIBLE BOARD (PAGE 4-17 of LEVEL 2)

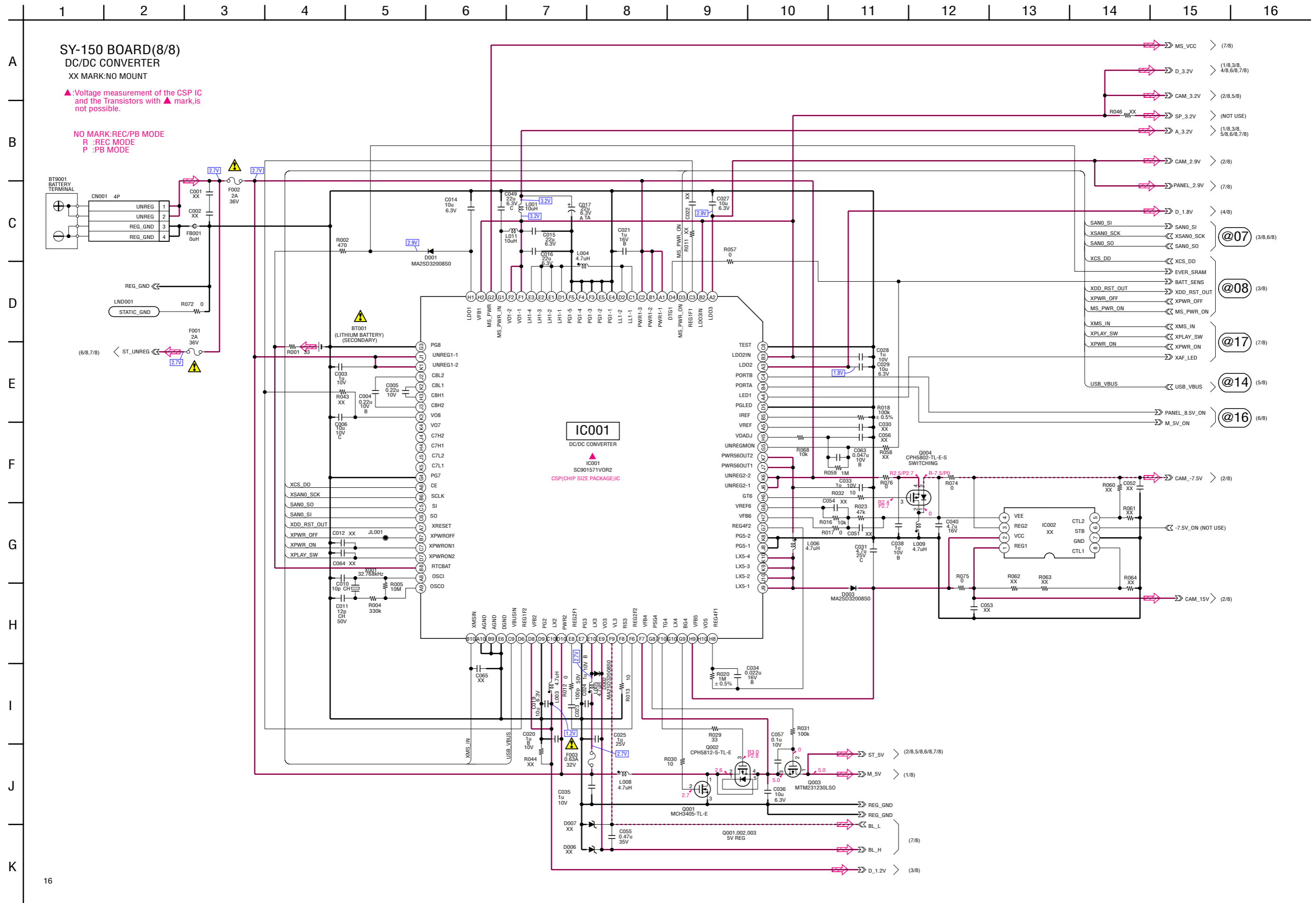


EVF UNIT is replaced as a block. So that this PRINTED WIRING BOARD and SCHEMATIC DIAGRAM are omitted.

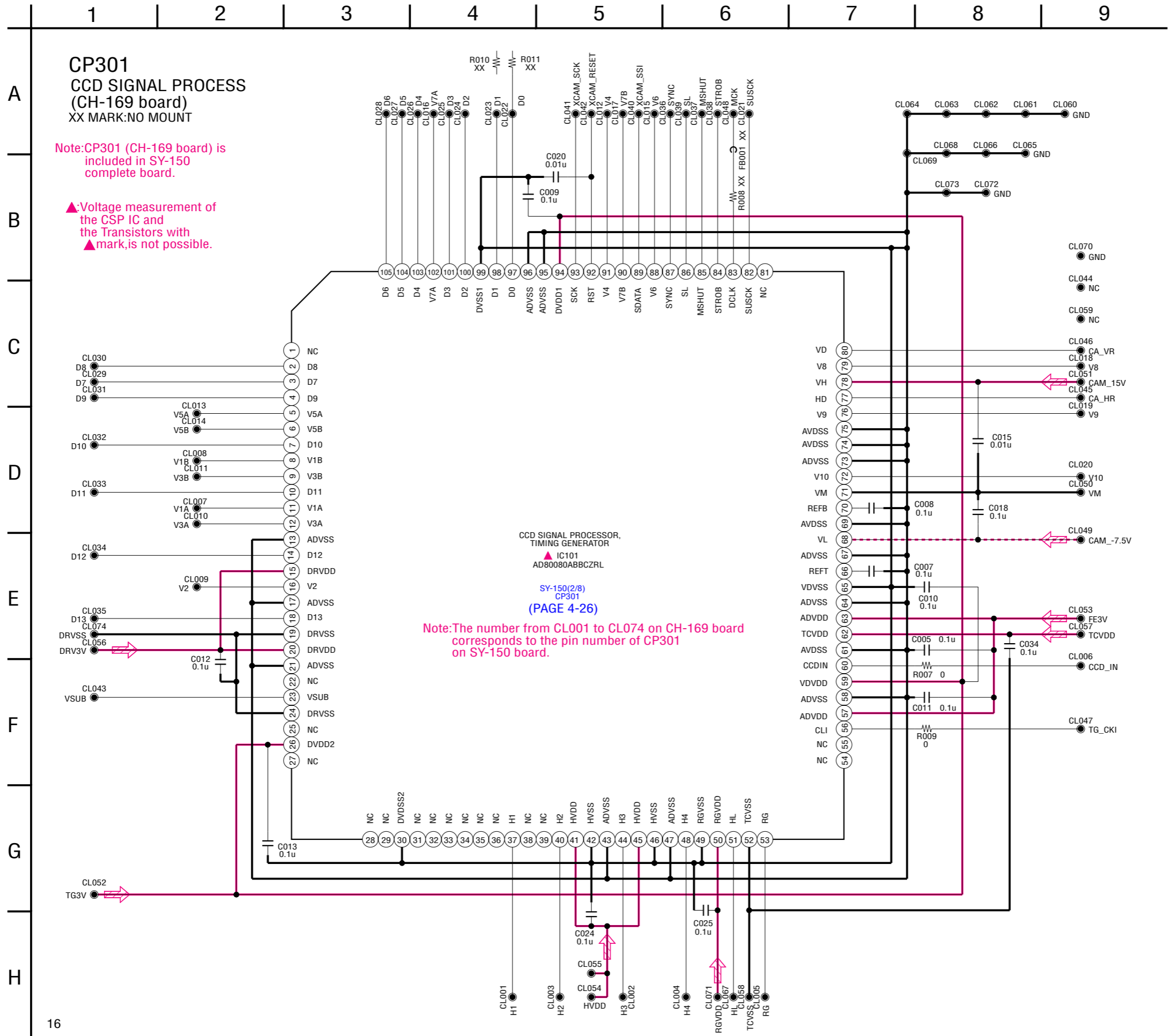
LCD9002  
EVF UNIT

TO SW-478 FLEXIBLE BOARD (PAGE 4-20 of LEVEL 2)

• Refer to page 4-3 for mark  $\Delta$ .



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## 4-3. PRINTED WIRING BOARDS

**Link**

<ul style="list-style-type: none"><li>• SY-150 BOARD (SIDE A)</li></ul>	<ul style="list-style-type: none"><li>• SY-150 BOARD (SIDE B)</li></ul>
<ul style="list-style-type: none"><li>• CH-169 BOARD</li></ul>	
<ul style="list-style-type: none"><li>• COMMON NOTE FOR PRINTED WIRING BOARDS</li></ul>	<ul style="list-style-type: none"><li>• MOUNTED PARTS LOCATION</li></ul>






## 4-3. PRINTED WIRING BOARDS

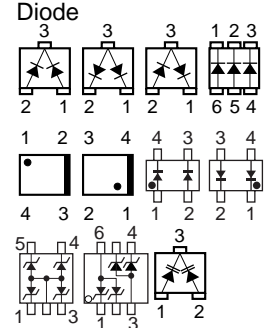
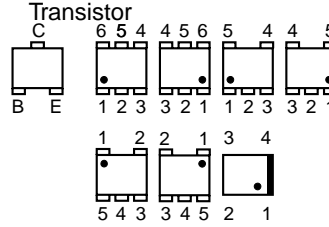
### 4-3. PRINTED WIRING BOARDS

**THIS NOTE IS COMMON FOR WIRING BOARDS**  
**(In addition to this, the necessary note is printed in each block)**

**(For printed wiring boards)**

-  : Uses unleaded solder.
-  : Pattern from the side which enables seeing.  
 (The other layers' patterns are not indicated)
- Through hole is omitted.
- There are a few cases that the part printed on diagram isn't mounted in this model.
-  : panel designation

• Chip parts.

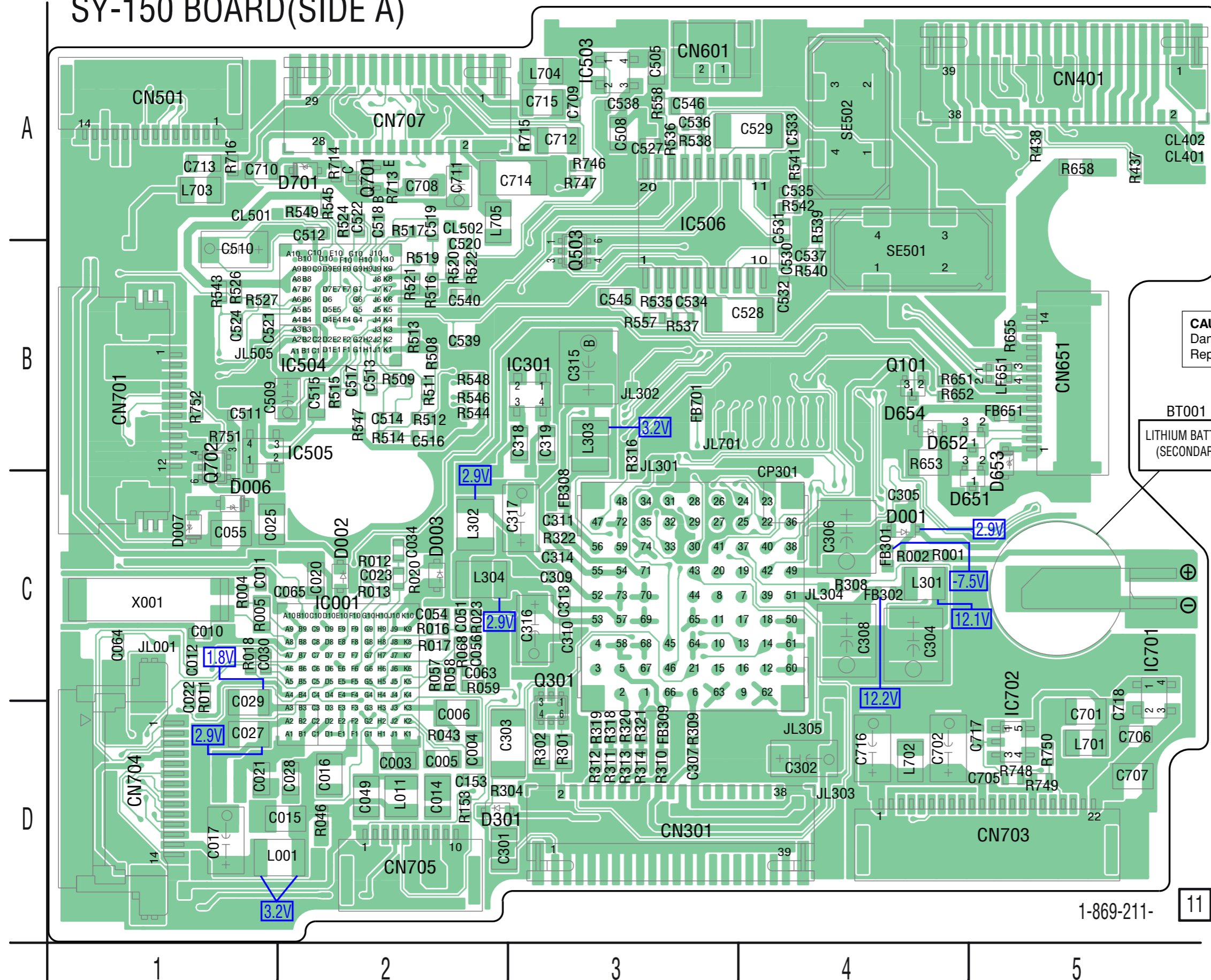


4-3. PRINTED WIRING BOARDS

SY-150 (8 layers) •  : Uses unleaded solder.

Note:CP301(CH-169 board) is not included in this COMPLETE of SY-150 board.

SY-150 BOARD(SIDE A)



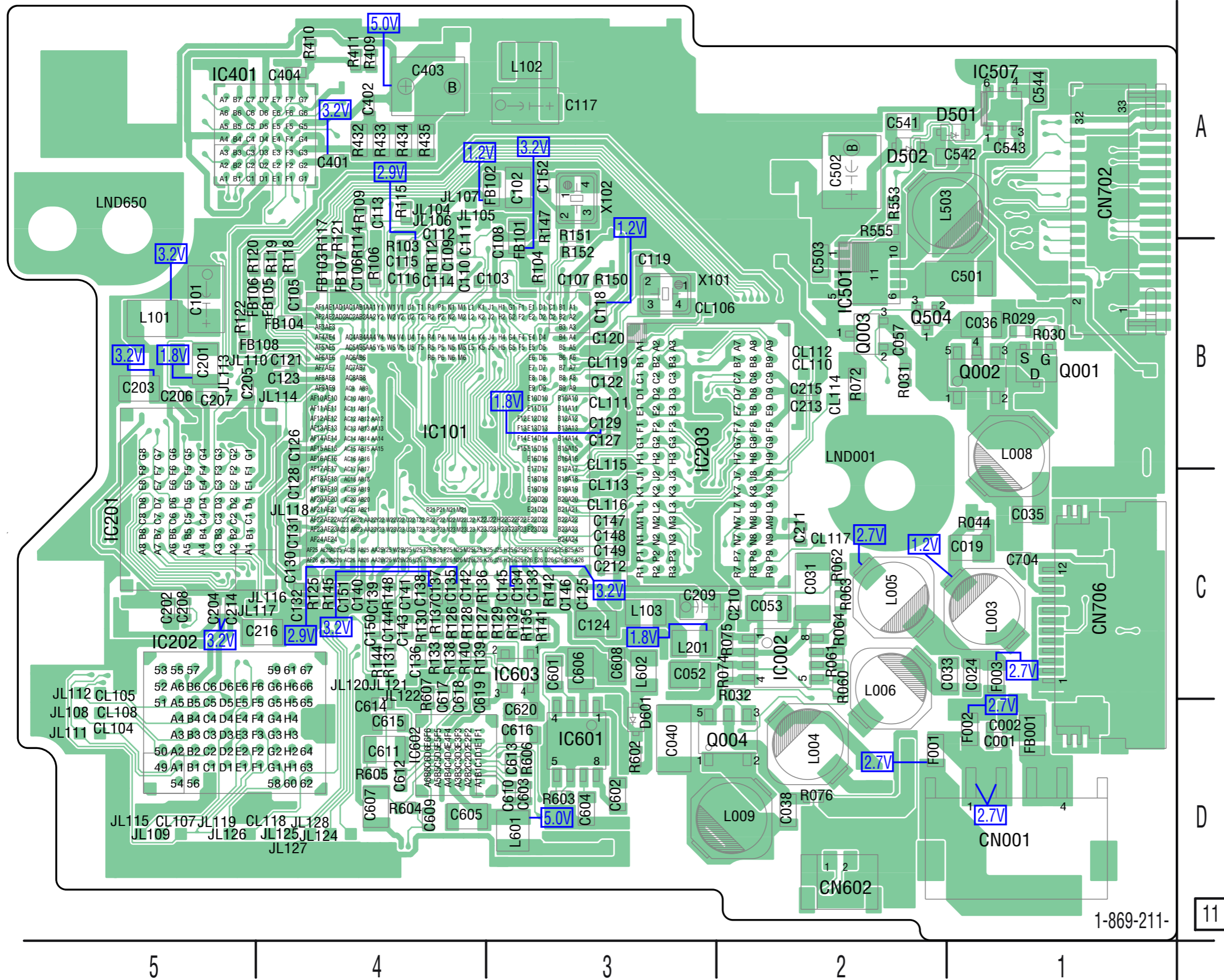
**CAUTION :**  
Danger of explosion if battery is incorrectly replaced.  
Replace only with the same or equivalent type.

BT001  
LITHIUM BATTERY  
(SECONDARY)

1-869-211- 11


SY-150 (8 layers) •  : Uses unleaded solder.

# SY-150 BOARD(SIDE B)



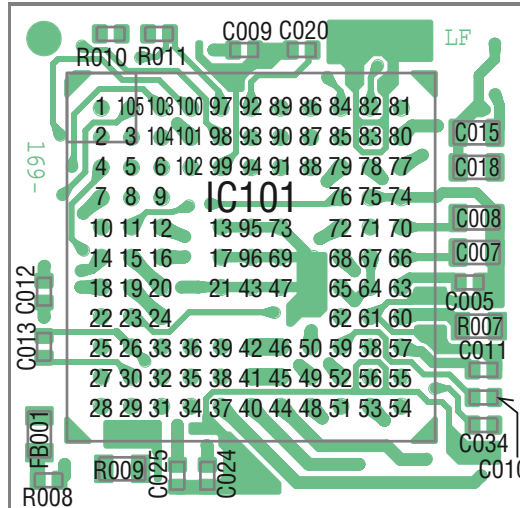
1-869-211-

11

-  : Uses unleaded solder.

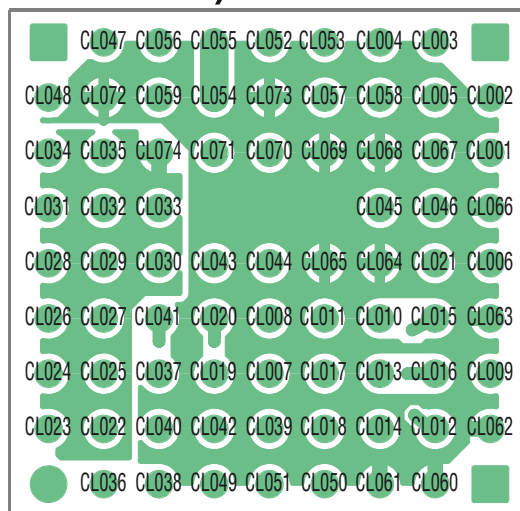
Note: CP301 (CH-169 board) is included in SY-150 complete board.

# CP301 (CH-169 board) (SIDE A)



1-865-271- 11

# (SIDE B)



1-865-271- 11



## 5. REPAIR PARTS LIST

**NOTE:**

- -XX, -X mean standardized parts, so they may have some differences from the original one.
- Items marked “\*” are not stocked since they are seldom required for routine service. Some delay should be anticipated when ordering these items.
- The mechanical parts with no reference number in the exploded views are not supplied.
- Due to standardization, replacements in the parts list may be different from the parts specified in the diagrams or the components used on the set.
- CAPACITORS:  
uF:  $\mu$ F
- COILS  
uH:  $\mu$ H
- RESISTORS  
All resistors are in ohms.  
METAL: metal-film resistor  
METAL OXIDE: Metal Oxide-film resistor  
F: nonflammable
- SEMICONDUCTORS  
In each case, u:  $\mu$ , for example:  
uA...:  $\mu$ A..., uPA...,  $\mu$ PA...,  
uPB...,  $\mu$ PB..., uPC...,  $\mu$ PC...,  
uPD...,  $\mu$ PD...

When indicating parts by reference number, please include the board name.

The components identified by mark  $\Delta$  or dotted line with mark  $\Delta$  are critical for safety. Replace only with part number specified.

Les composants identifiés par une marque  $\Delta$  sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

**Language that can be selected about SY-150 board**

	Area	English	French	German	Spanish	Italian	Portugal	Simplified Chinese	Traditional Chinese	Arabic	Dutch	Russian	Swedish	Korean	Norwegian	Danish	Finnish	Polish	Hungarian	Czech	Persian	Thai	
GP2	US CND AUS Vietnam	●	●		●	●		●	●														
GP3	AEP UK	●	●	●	●	●	●				●	●	●		●	●	●	●	●	●	●		
GP4	E AR JE HK CH KR	●			●		●	●	●	●				●								●	●

- Abbreviation  
AR : Argentine model  
AUS : Australian model  
CH : Chinese model  
CND : Canadian model  
HK : Hong Kong model  
JE : Tourist model  
KR : Korea model

## 5-2. ELECTRICAL PARTS LIST

Ref. No.	Part No.	Description	Ref. No.	Part No.	Description
	A-1176-916-A	SY-150 BOARD, COMPLETE (SERVICE)(GP2)	C119	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
	A-1176-917-A	SY-150 BOARD, COMPLETE (SERVICE)(GP3)	C120	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
	A-1176-918-A	SY-150 BOARD, COMPLETE (SERVICE)(GP4)	C121	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
	*****				
	(Refer to the table of page 5-1 about language of SY-150 board.)				
	(This complete board is including CP301(CH-169 board).)				
CP301	A-1106-355-A	CH-169 BOARD, COMPLETE	C122	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
		< BATTERY >	C123	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
△ BT001	1-756-539-21	BATTERY, LITHIUM SECONDARY	C125	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
		< CAPACITOR >	C126	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C003	1-165-908-11	CERAMIC CHIP 1uF 10% 10V	C127	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C004	1-115-467-11	CERAMIC CHIP 0.22uF 10% 10V	C128	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C005	1-115-467-11	CERAMIC CHIP 0.22uF 10% 10V	C129	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C006	1-100-966-91	CERAMIC CHIP 10uF 20% 10V	C130	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C010	1-164-850-11	CERAMIC CHIP 10PF 0.5PF 50V	C131	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C011	1-164-852-11	CERAMIC CHIP 12PF 5% 50V	C132	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C014	1-137-710-11	CERAMIC CHIP 10uF 20% 6.3V	C133	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C015	1-100-611-91	CERAMIC CHIP 22uF 20% 6.3V	C134	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C016	1-100-611-91	CERAMIC CHIP 22uF 20% 6.3V	C135	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C017	1-119-750-11	TANTAL. CHIP 22uF 20% 6.3V	C136	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C019	1-137-710-11	CERAMIC CHIP 10uF 20% 6.3V	C137	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C020	1-165-908-11	CERAMIC CHIP 1uF 10% 10V	C138	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
* C021	1-112-298-91	CERAMIC CHIP 1uF 10% 16V	C139	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C023	1-164-874-11	CERAMIC CHIP 100PF 5% 50V	C140	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C024	1-165-908-11	CERAMIC CHIP 1uF 10% 10V	C142	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C025	1-100-591-91	CERAMIC CHIP 1uF 10% 25V	C145	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C027	1-137-710-11	CERAMIC CHIP 10uF 20% 6.3V	C149	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C028	1-165-908-11	CERAMIC CHIP 1uF 10% 10V	C150	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C029	1-137-710-11	CERAMIC CHIP 10uF 20% 6.3V	C151	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C031	1-100-671-11	CERAMIC CHIP 4.7uF 20% 25V	C152	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C033	1-165-908-11	CERAMIC CHIP 1uF 10% 10V	C153	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C034	1-107-819-11	CERAMIC CHIP 0.022uF 10% 16V	C203	1-137-710-11	CERAMIC CHIP 10uF 20% 6.3V
C035	1-165-908-11	CERAMIC CHIP 1uF 10% 10V	C204	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C036	1-137-710-11	CERAMIC CHIP 10uF 20% 6.3V	C205	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C038	1-165-908-11	CERAMIC CHIP 1uF 10% 10V	C206	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C040	1-127-820-11	CERAMIC CHIP 4.7uF 10% 16V	C207	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C049	1-100-611-91	CERAMIC CHIP 22uF 20% 6.3V	C208	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C055	1-100-591-91	CERAMIC CHIP 1uF 10% 25V	C209	1-100-786-91	TANTAL. CHIP 22uF 20% 6.3V
C057	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V	C210	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C063	1-119-923-11	CERAMIC CHIP 0.047uF 10% 10V	C211	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C101	1-119-750-11	TANTAL. CHIP 22uF 20% 6.3V	C212	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C102	1-137-710-11	CERAMIC CHIP 10uF 20% 6.3V	C213	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C103	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V	C214	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C105	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V	C301	1-115-339-11	CERAMIC CHIP 0.1uF 10% 50V
C106	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V	C302	1-104-851-11	TANTAL. CHIP 10uF 20% 10V
C107	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V	C303	1-137-988-91	CERAMIC CHIP 1uF 10% 35V
C108	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V	C304	1-113-992-11	TANTAL. CHIP 3.3uF 20% 35V
C109	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V	C306	1-119-751-11	TANTAL. CHIP 22uF 20% 16V
C110	1-164-939-11	CERAMIC CHIP 0.0022uF 10% 50V	C307	1-100-505-91	CERAMIC CHIP 0.1uF 20% 16V
C111	1-164-939-11	CERAMIC CHIP 0.0022uF 10% 50V	C308	1-113-992-11	TANTAL. CHIP 3.3uF 20% 35V
C114	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V	C314	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
C115	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V	C315	1-128-964-91	TANTAL. CHIP 100uF 20% 6.3V
C116	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V	C316	1-100-539-91	TANTAL. CHIP 47uF 20% 6.3V
C117	1-119-750-11	TANTAL. CHIP 22uF 20% 6.3V	C317	1-100-539-91	TANTAL. CHIP 47uF 20% 6.3V
C118	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V	C318	1-165-908-11	CERAMIC CHIP 1uF 10% 10V
			C319	1-165-908-11	CERAMIC CHIP 1uF 10% 10V
			C401	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V
			C402	1-125-777-11	CERAMIC CHIP 0.1uF 10% 10V

Ref. No.	Part No.	Description			
C403	1-100-663-11	TANTAL. CHIP	22uF	20%	10V
C501	1-165-875-11	CERAMIC CHIP	10uF	10%	10V
C502	1-135-993-11	TANTAL. CHIP	33uF	20%	10V
C503	1-165-884-91	CERAMIC CHIP	2.2uF	10%	6.3V
C505	1-165-908-11	CERAMIC CHIP	1uF	10%	10V
C508	1-165-908-11	CERAMIC CHIP	1uF	10%	10V
C510	1-165-897-11	TANTAL. CHIP	22uF	20%	10V
C511	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V
C512	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V
C513	1-164-937-11	CERAMIC CHIP	0.001uF	10%	50V
C514	1-164-939-11	CERAMIC CHIP	0.0022uF	10%	50V
C515	1-165-908-11	CERAMIC CHIP	1uF	10%	10V
C517	1-164-943-81	CERAMIC CHIP	0.01uF	10%	16V
C518	1-164-937-11	CERAMIC CHIP	0.001uF	10%	50V
C519	1-164-939-11	CERAMIC CHIP	0.0022uF	10%	50V
C522	1-164-943-81	CERAMIC CHIP	0.01uF	10%	16V
C527	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V
C528	1-100-159-91	CERAMIC CHIP	22uF	10%	6.3V
C529	1-100-159-91	CERAMIC CHIP	22uF	10%	6.3V
C530	1-119-923-11	CERAMIC CHIP	0.047uF	10%	10V
C531	1-119-923-11	CERAMIC CHIP	0.047uF	10%	10V
C532	1-119-923-11	CERAMIC CHIP	0.047uF	10%	10V
C533	1-119-923-11	CERAMIC CHIP	0.047uF	10%	10V
C534	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V
C535	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V
C536	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V
C537	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V
C538	1-164-943-81	CERAMIC CHIP	0.01uF	10%	16V
C541	1-165-884-91	CERAMIC CHIP	2.2uF	10%	6.3V
C542	1-125-837-91	CERAMIC CHIP	1uF	10%	6.3V
C543	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V
C544	1-165-908-11	CERAMIC CHIP	1uF	10%	10V
C545	1-128-934-61	CERAMIC CHIP	0.33uF	10%	10V
C546	1-128-934-61	CERAMIC CHIP	0.33uF	10%	10V
C601	1-100-352-91	CERAMIC CHIP	1uF	20%	16V
C602	1-100-352-91	CERAMIC CHIP	1uF	20%	16V
C603	1-100-415-11	CERAMIC CHIP	0.47uF	10%	6.3V
C604	1-100-352-91	CERAMIC CHIP	1uF	20%	16V
C605	1-137-710-11	CERAMIC CHIP	10uF	20%	6.3V
C606	1-137-710-11	CERAMIC CHIP	10uF	20%	6.3V
C607	1-137-710-11	CERAMIC CHIP	10uF	20%	6.3V
C608	1-100-352-91	CERAMIC CHIP	1uF	20%	16V
C609	1-164-943-81	CERAMIC CHIP	0.01uF	10%	16V
C610	1-164-937-11	CERAMIC CHIP	0.001uF	10%	50V
C611	1-115-339-11	CERAMIC CHIP	0.1uF	10%	50V
C612	1-164-943-81	CERAMIC CHIP	0.01uF	10%	16V
C613	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V
C614	1-107-819-11	CERAMIC CHIP	0.022uF	10%	16V
C615	1-165-908-11	CERAMIC CHIP	1uF	10%	10V
C616	1-165-908-11	CERAMIC CHIP	1uF	10%	10V
C617	1-164-943-81	CERAMIC CHIP	0.01uF	10%	16V
C618	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V
C619	1-165-908-11	CERAMIC CHIP	1uF	10%	10V
C620	1-165-908-11	CERAMIC CHIP	1uF	10%	10V
C701	1-127-760-11	CERAMIC CHIP	4.7uF	10%	6.3V

Ref. No.	Part No.	Description			
C704	1-125-777-11	CERAMIC CHIP	0.1uF	10%	10V
C705	1-164-943-81	CERAMIC CHIP	0.01uF	10%	16V
C706	1-107-826-11	CERAMIC CHIP	0.1uF	10%	16V
C707	1-137-710-11	CERAMIC CHIP	10uF	20%	6.3V
C716	1-165-897-11	TANTAL. CHIP	22uF	20%	10V
< CONNECTOR >					
CN001	1-580-057-11	PIN, CONNECTOR (SMD) 4P			
* CN301	1-816-057-51	CONNECTOR, FPC (ZIF) 39P			
* CN401	1-816-057-51	CONNECTOR, FPC (ZIF) 39P			
* CN501	1-816-645-51	FFC/FPC CONNECTOR (LIF) 14P			
CN601	1-794-375-21	PIN, CONNECTOR 2P			
CN602	1-794-375-21	PIN, CONNECTOR 2P			
* CN651	1-816-645-51	FFC/FPC CONNECTOR (LIF) 14P			
CN701	1-819-254-51	CONNECTOR, FFC/FPC (ZIF) 12P			
* CN702	1-815-333-51	CONNECTOR, FPC (ZIF) 33P			
* CN703	1-816-649-51	FFC/FPC CONNECTOR (LIF) 22P			
* CN704	1-819-257-51	CONNECTOR, FFC/FPC (ZIF) 14P			
* CN705	1-816-643-51	FFC/FPC CONNECTOR (LIF) 10P			
CN706	1-819-254-51	CONNECTOR, FFC/FPC (ZIF) 12P			
< DIODE >					
D001	6-500-813-01	DIODE MA2SD32008S0			
D002	6-500-813-01	DIODE MA2SD32008S0			
D003	6-500-813-01	DIODE MA2SD32008S0			
D301	8-719-056-23	DIODE MA2S111-(K8).SO			
D501	6-500-813-01	DIODE MA2SD32008S0			
D502	6-500-813-01	DIODE MA2SD32008S0			
D601	8-719-056-23	DIODE MA2S111-(K8).SO			
D651	6-500-776-01	DIODE MAZW068H0LS0			
D652	6-500-776-01	DIODE MAZW068H0LS0			
D653	8-719-056-54	DIODE MAZS068008S0			
D654	8-719-056-23	DIODE MA2S111-(K8).SO			
< FUSE >					
△ F001	1-576-416-21	FUSE (2A/36V)			
△ F002	1-576-416-21	FUSE (2A/36V)			
△ F003	1-576-570-21	FUSE, MICRO (1608 TYPE)(0.63A/32V)			
< FERRITE BEAD >					
FB001	1-469-324-21	INDUCTOR (EMI FERRITE) (2012)			
FB101	1-500-284-21	INDUCTOR, FERRITE BEAD			
FB102	1-216-864-11	SHORT CHIP 0 (Note2)			
FB103	1-469-581-21	INDUCTOR, FERRITE BEAD (1005)			
FB104	1-469-581-21	INDUCTOR, FERRITE BEAD (1005)			
FB105	1-469-581-21	INDUCTOR, FERRITE BEAD (1005)			
FB106	1-469-581-21	INDUCTOR, FERRITE BEAD (1005)			
FB107	1-469-581-21	INDUCTOR, FERRITE BEAD (1005)			
FB108	1-469-581-21	INDUCTOR, FERRITE BEAD (1005)			
FB301	1-469-082-21	INDUCTOR, FERRITE BEAD (1005)			
FB302	1-469-082-21	INDUCTOR, FERRITE BEAD (1005)			
FB308	1-400-331-11	FERRITE, EMI (SMD) (1005)			
FB309	1-218-990-81	SHORT CHIP 0 (Note2)			
FB651	1-469-580-11	INDUCTOR, FERRITE BEAD (1005)			
FB701	1-469-580-11	INDUCTOR, FERRITE BEAD (1005)			

**Note 2 :**

SHORT CHIP is mounted to the location where FB102 and FB309 are printed.



Ref. No.	Part No.	Description	Ref. No.	Part No.	Description
< IC >			< RESISTOR >		
* IC001	6-709-120-01	IC SC901571VOR2	R001	1-218-935-11	RES-CHIP 33 5% 1/16W
IC101	8-753-239-15	IC CXD3188AGG-T6	R002	1-218-949-11	RES-CHIP 470 5% 1/16W
IC201	Not supplied	IC PH28F320W30TD70-A01 (Note1)	R004	1-218-983-11	RES-CHIP 330K 5% 1/16W
* IC202	6-709-151-01	IC KFG5616U1A-DIB5T (Note2)	R005	1-219-570-11	METAL CHIP 10M 5% 1/10W
* IC203	6-708-803-01	IC K4M56323PG-HG75T	R007	1-218-990-81	SHORT CHIP 0
IC301	6-703-977-01	IC R1114Q331D-TR-FA	R009	1-218-990-81	SHORT CHIP 0
IC401	6-708-988-01	IC LV8053LG-TLM-E	R012	1-218-990-81	SHORT CHIP 0
IC501	6-707-643-01	IC TPS61027DRCR	R013	1-208-635-11	METAL CHIP 10 0.5% 1/16W
* IC503	6-708-445-01	IC R1114Q291D-TR-FA	R016	1-208-911-11	METAL CHIP 10K 0.5% 1/16W
* IC504	6-709-026-01	IC R2J30500LG	R017	1-218-990-81	SHORT CHIP 0
* IC505	6-708-457-01	IC R1114Q151D-TR-FA	R018	1-208-935-11	METAL CHIP 100K 0.5% 1/16W
IC506	8-759-489-19	IC uPC6756GR-8JG-E2	R020	1-218-989-11	RES-CHIP 1M 5% 1/16W
* IC507	6-709-332-01	IC TK70685HCL-G	R023	1-208-927-11	METAL CHIP 47K 0.5% 1/16W
* IC601	6-708-096-01	IC NJW1330RB1 (TE2)	R029	1-218-935-11	RES-CHIP 33 5% 1/16W
IC602	6-707-336-01	IC BH6414GLU-E2	R030	1-218-929-11	RES-CHIP 10 5% 1/16W
* IC603	6-708-445-01	IC R1114Q291D-TR-FA	R031	1-218-977-11	RES-CHIP 100K 5% 1/16W
* IC701	6-708-464-01	IC R1114Q251D-TR-FA	R032	1-218-929-11	RES-CHIP 10 5% 1/16W
< COIL >			R057	1-218-990-81	SHORT CHIP 0
L001	1-469-967-21	INDUCTOR 10uH	R059	1-218-989-11	RES-CHIP 1M 5% 1/16W
L003	1-456-995-22	INDUCTOR 4.7uH	R068	1-218-965-11	RES-CHIP 10K 5% 1/16W
L004	1-456-995-22	INDUCTOR 4.7uH	R072	1-216-864-11	SHORT CHIP 0
L005	1-456-995-22	INDUCTOR 4.7uH	R074	1-218-990-81	SHORT CHIP 0
L006	1-456-995-22	INDUCTOR 4.7uH	R075	1-218-990-81	SHORT CHIP 0
L008	1-456-995-22	INDUCTOR 4.7uH	R076	1-218-990-81	SHORT CHIP 0
L009	1-456-995-22	INDUCTOR 4.7uH	R103	1-218-990-81	SHORT CHIP 0
L011	1-469-555-21	INDUCTOR 10uH	R106	1-208-679-11	METAL CHIP 680 0.5% 1/16W
L101	1-469-967-21	INDUCTOR 10uH	R109	1-218-973-11	RES-CHIP 47K 5% 1/16W
L102	1-469-967-21	INDUCTOR 10uH	R112	1-208-683-11	METAL CHIP 1K 0.5% 1/16W
L201	1-400-588-11	INDUCTOR 10uH	R114	1-218-985-11	RES-CHIP 470K 5% 1/16W
L301	1-469-561-21	INDUCTOR 100uH	R115	1-208-683-11	METAL CHIP 1K 0.5% 1/16W
L302	1-469-967-21	INDUCTOR 10uH	R117	1-218-941-81	RES-CHIP 100 5% 1/16W
L303	1-400-317-21	INDUCTOR 100uH	R118	1-218-941-81	RES-CHIP 100 5% 1/16W
L304	1-469-967-21	INDUCTOR 10uH	R119	1-218-941-81	RES-CHIP 100 5% 1/16W
L503	1-456-995-22	INDUCTOR 4.7uH	R120	1-218-941-81	RES-CHIP 100 5% 1/16W
L601	1-469-555-21	INDUCTOR 10uH	R121	1-218-939-11	RES-CHIP 68 5% 1/16W
L602	1-400-588-11	INDUCTOR 10uH	R122	1-218-939-11	RES-CHIP 68 5% 1/16W
L701	1-412-006-31	INDUCTOR 10uH	R125	1-218-965-11	RES-CHIP 10K 5% 1/16W
L702	1-412-006-31	INDUCTOR 10uH	R126	1-218-965-11	RES-CHIP 10K 5% 1/16W
< LINE FILTER >			R127	1-218-965-11	RES-CHIP 10K 5% 1/16W
LF651	1-456-583-11	COMMON MODE CHOKE COIL	R128	1-218-965-11	RES-CHIP 10K 5% 1/16W
< TRANSISTOR >			R129	1-218-965-11	RES-CHIP 10K 5% 1/16W
Q001	8-729-056-01	TRANSISTOR MCH3405-TL-E	R130	1-218-965-11	RES-CHIP 10K 5% 1/16W
Q002	6-550-351-01	TRANSISTOR CPH5812-S-TL-E	R131	1-218-965-11	RES-CHIP 10K 5% 1/16W
Q003	6-551-304-01	TRANSISTOR MTM231230LSO	R132	1-218-965-11	RES-CHIP 10K 5% 1/16W
Q004	8-729-053-76	TRANSISTOR CPH5802-TL-E-S	R133	1-208-935-11	METAL CHIP 100K 0.5% 1/16W
Q301	8-729-053-58	TRANSISTOR RN1904FE (TPLR3)	R135	1-208-911-11	METAL CHIP 10K 0.5% 1/16W
Q503	6-550-094-01	TRANSISTOR EMH2-T2R	R136	1-218-973-11	RES-CHIP 47K 5% 1/16W
Q504	6-550-239-01	TRANSISTOR DTA144EMT2L	R137	1-208-943-11	METAL CHIP 220K 0.5% 1/16W
			R138	1-218-965-11	RES-CHIP 10K 5% 1/16W
			R139	1-218-965-11	RES-CHIP 10K 5% 1/16W
			R140	1-218-981-11	RES-CHIP 220K 5% 1/16W
			R141	1-218-981-11	RES-CHIP 220K 5% 1/16W
			R144	1-218-965-11	RES-CHIP 10K 5% 1/16W
			R145	1-218-965-11	RES-CHIP 10K 5% 1/16W
			R148	1-218-953-11	RES-CHIP 1K 5% 1/16W

**Note 1 :**

A service for IC201 is not available because an adjustment is required before replacement.

**Note 2:**

When IC202 is replaced, formatting is required. Execute formatting by referring to Supplement-1.

Ref. No.	Part No.	Description				Ref. No.	Part No.	Description			
R151	1-218-990-81	SHORT CHIP	0			R605	1-218-985-11	RES-CHIP	470K	5%	1/16W
R153	1-218-965-11	RES-CHIP	10K	5%	1/16W	R606	1-218-972-11	RES-CHIP	39K	5%	1/16W
R301	1-218-857-11	METAL CHIP	2.7K	0.5%	1/10W	R607	1-218-957-11	RES-CHIP	2.2K	5%	1/16W
R302	1-218-859-11	METAL CHIP	3.3K	0.5%	1/10W	R651	1-218-965-11	RES-CHIP	10K	5%	1/16W
R304	1-218-977-11	RES-CHIP	100K	5%	1/16W	R652	1-218-965-11	RES-CHIP	10K	5%	1/16W
R308	1-218-977-11	RES-CHIP	100K	5%	1/16W	R653	1-216-295-91	SHORT CHIP	0		
R309	1-218-990-81	SHORT CHIP	0			R658	1-216-864-11	SHORT CHIP	0		
R310	1-218-935-11	RES-CHIP	33	5%	1/16W	R747	1-218-990-81	SHORT CHIP	0		
R311	1-208-455-11	RES-CHIP	5.6	5%	1/16W	R749	1-218-990-81	SHORT CHIP	0		
R312	1-208-455-11	RES-CHIP	5.6	5%	1/16W			< SENSOR >			
R313	1-208-455-11	RES-CHIP	5.6	5%	1/16W	* SE501	1-479-022-51	SENSOR, ANGULAR VELOCITY (PITCH)			
R314	1-208-455-11	RES-CHIP	5.6	5%	1/16W	* SE502	1-479-022-61	SENSOR, ANGULAR VELOCITY (YAW)			
R316	1-218-990-81	SHORT CHIP	0					< VIBRATOR >			
R318	1-218-990-81	SHORT CHIP	0			X001	1-767-994-23	VIBRATOR, CRYSTAL (32.768kHz)			
R319	1-218-990-81	SHORT CHIP	0			* X101	1-813-403-21	QUARTZ CRYSTAL OSCILLATOR (12MHz)			
R320	1-218-990-81	SHORT CHIP	0			* X102	1-813-712-21	QUARTZ CRYSTAL OSCILLATOR (33.75MHz)			
R321	1-218-990-81	SHORT CHIP	0								
R409	1-208-715-11	METAL CHIP	22K	0.5%	1/16W						
R410	1-208-715-11	METAL CHIP	22K	0.5%	1/16W						
R411	1-208-927-11	METAL CHIP	47K	0.5%	1/16W						
R432	1-211-969-11	METAL CHIP	10	0.5%	1/10W						
R433	1-211-969-11	METAL CHIP	10	0.5%	1/10W						
R434	1-211-969-11	METAL CHIP	10	0.5%	1/10W						
R435	1-211-969-11	METAL CHIP	10	0.5%	1/10W						
R437	1-218-948-11	RES-CHIP	390	5%	1/16W						
R438	1-218-948-11	RES-CHIP	390	5%	1/16W						
R509	1-208-721-11	METAL CHIP	39K	0.5%	1/16W						
R511	1-218-970-11	RES-CHIP	27K	5%	1/16W						
R512	1-208-695-11	METAL CHIP	3.3K	0.5%	1/16W						
R513	1-208-909-11	METAL CHIP	8.2K	0.5%	1/16W						
R515	1-208-911-11	METAL CHIP	10K	0.5%	1/16W						
R517	1-208-721-11	METAL CHIP	39K	0.5%	1/16W						
R519	1-218-970-11	RES-CHIP	27K	5%	1/16W						
R520	1-208-695-11	METAL CHIP	3.3K	0.5%	1/16W						
R521	1-208-909-11	METAL CHIP	8.2K	0.5%	1/16W						
R524	1-208-911-11	METAL CHIP	10K	0.5%	1/16W						
R526	1-218-965-11	RES-CHIP	10K	5%	1/16W						
R527	1-218-990-81	SHORT CHIP	0								
R535	1-218-989-11	RES-CHIP	1M	5%	1/16W						
R536	1-218-989-11	RES-CHIP	1M	5%	1/16W						
R537	1-218-965-11	RES-CHIP	10K	5%	1/16W						
R538	1-218-965-11	RES-CHIP	10K	5%	1/16W						
R539	1-218-969-11	RES-CHIP	22K	5%	1/16W						
R540	1-218-969-11	RES-CHIP	22K	5%	1/16W						
R541	1-218-969-11	RES-CHIP	22K	5%	1/16W						
R542	1-218-969-11	RES-CHIP	22K	5%	1/16W						
R543	1-218-977-11	RES-CHIP	100K	5%	1/16W						
R544	1-218-977-11	RES-CHIP	100K	5%	1/16W						
R545	1-218-977-11	RES-CHIP	100K	5%	1/16W						
R546	1-218-977-11	RES-CHIP	100K	5%	1/16W						
R547	1-218-977-11	RES-CHIP	100K	5%	1/16W						
R548	1-218-977-11	RES-CHIP	100K	5%	1/16W						
R549	1-218-977-11	RES-CHIP	100K	5%	1/16W						
R553	1-218-977-11	RES-CHIP	100K	5%	1/16W						
R555	1-218-985-11	RES-CHIP	470K	5%	1/16W						
R557	1-218-967-11	RES-CHIP	15K	5%	1/16W						
R558	1-218-967-11	RES-CHIP	15K	5%	1/16W						
R602	1-218-929-11	RES-CHIP	10	5%	1/16W						
R603	1-218-939-11	RES-CHIP	68	5%	1/16W						
R604	1-218-955-11	RES-CHIP	1.5K	5%	1/16W						

# DSC-H2

SONY®

## SERVICE MANUAL

Ver. 1.1 2006.07

LEVEL 3

*US Model  
Canadian Model  
AEP Model  
UK Model  
E Model  
Australian Model  
Chinese Model  
Argentina Model  
Hong Kong Model  
Korea Model  
Tourist Model*

## SUPPLEMENT-1

File this supplement-1 with the service manual.  
(DI06-030)

- Addition of formatting procedure after replacement of IC202

### 1. SERVICE NOTE

Page	Added contents
1-1E	<p><b>Formatting Procedure after Replacement of IC202</b></p> <ol style="list-style-type: none"><li>1. Insert an MS (Memory Stick Duo) into the machine and turn ON the power. Connect the machine to SEUS while the message "Internal memory error" is being displayed. * Because the machine is in the error state, an MS is required to make the USB communication.</li><li>2. Select page: 90, address: 32 and set data: 01.</li><li>3. Remove the MS. * When the MS is removed, "Initial format" starts. The access LED lights for 3 to 5 seconds, and the error display changes to "Format error".</li><li>4. Select and execute "Format" from the setup menu. (The access LED lights for 15 seconds.)</li><li>5. When the access LED lights off, it indicates that the formatting is completed. Confirm to see that the error indication has disappeared. Remove the SEUS connection and turn OFF the power.</li></ol>

# DSC-H2

SONY®

LEVEL 3

## SERVICE MANUAL

Ver. 1.3 2006.10

US Model  
Canadian Model  
AEP Model  
UK Model  
E Model  
Australian Model  
Chinese Model  
Argentina Model  
Hong Kong Model  
Korea Model  
Tourist Model

## SUPPLEMENT-2


File this supplement-2 with the service manual.  
(DI06-116)

- Change of boards suffix number (SY-150)
- Change of repair parts list

- Change of repair parts list

### 5. REPAIR PARTS LIST

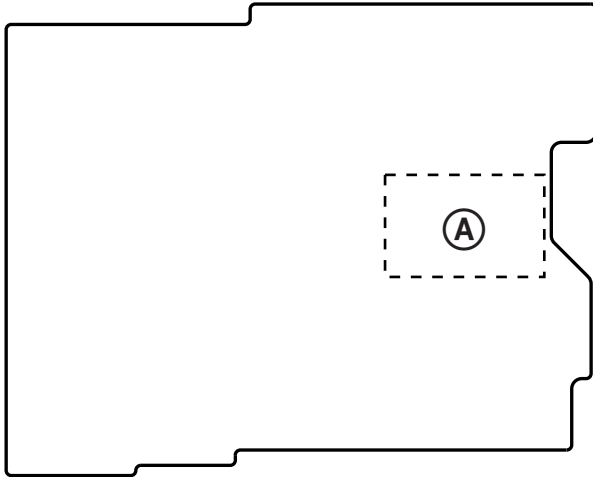
#### 5-2. ELECTRICAL PARTS LIST

 : Changed portion

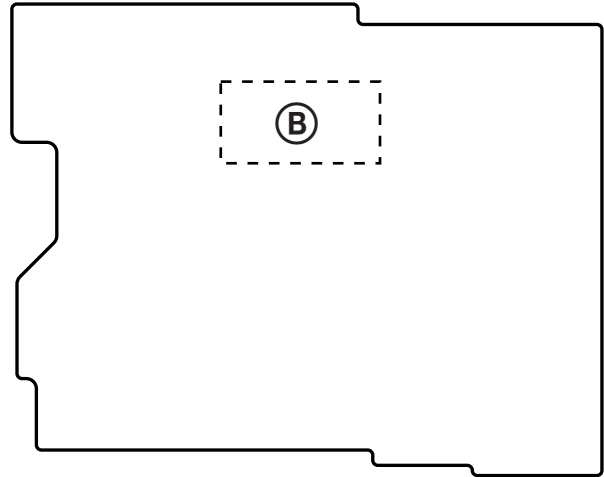
Page	Before change			After change		
5-12	<b>SY-150 BOARD</b>					
	<u>Ref. No.</u>	<u>Part No.</u>	<u>Description</u>	<u>Ref. No.</u>	<u>Part No.</u>	<u>Description</u>
	△ BT001	1-756-539-21	BATTERY, LITHIUM SECONDARY	△ BT001	1-528-999-61	BATTERY, LITHIUM SECONDARY
5-13	FB651	1-469-580-11	INDUCTOR, FERRITE BEAD (1005)	FB651	1-469-580-21	INDUCTOR, FERRITE BEAD (1005)
	FB701	1-469-580-11	INDUCTOR, FERRITE BEAD (1005)	FB701	1-469-580-21	INDUCTOR, FERRITE BEAD (1005)

• How to identify and difference points of the printed wiring boards (SY-150 BOARD)

SY-150 BOARD (SIDE A)



SY-150 BOARD (SIDE B)



	Suffix -11	Suffix -21
A		
B		



• Change of boards suffix number (SY-150)

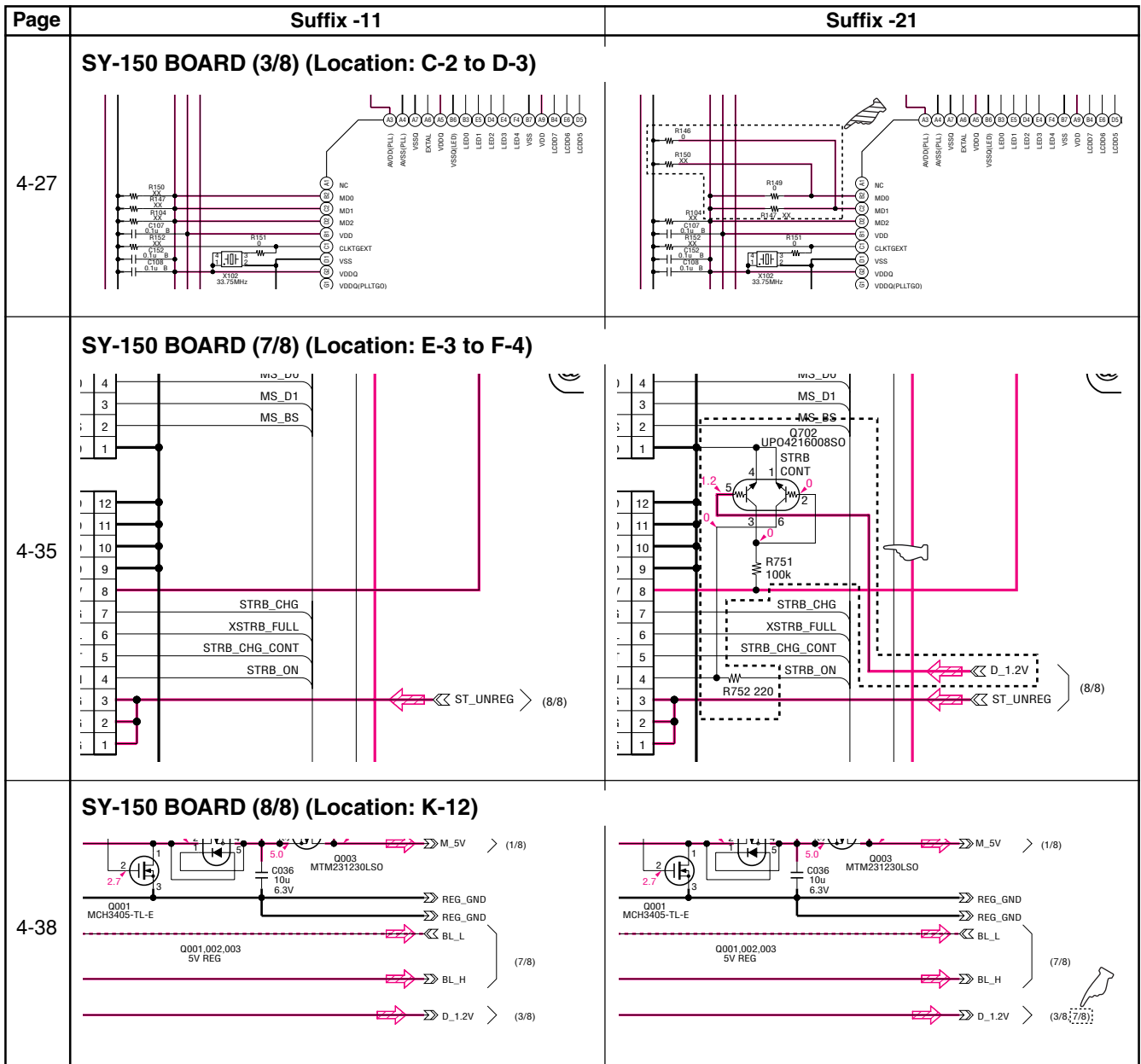
4. PRINTED WIRING BOARDS AND SCHEMATIC DIAGRAMS

4-2. SCHEMATIC DIAGRAMS

: Added portion


Page	Suffix -11	Suffix -21
4-26	<p>SY-150 BOARD (2/8) (Location: H-8)</p>	

 : Changed portion  : Added portion



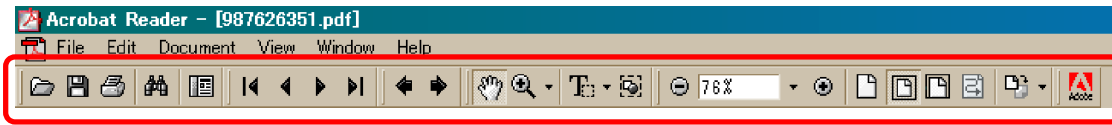
## 5. REPAIR PARTS LIST

### 5-2. ELECTRICAL PARTS LIST

 : Added portion


Page	Suffix -11	Suffix -21																									
5-14	<b>SY-150 BOARD</b> <table border="1"> <thead> <tr> <th>Ref. No.</th> <th>Part No.</th> <th>Description</th> </tr> </thead> <tbody> <tr><td>—</td><td>—</td><td>—</td></tr> <tr><td>—</td><td>—</td><td>—</td></tr> </tbody> </table>	Ref. No.	Part No.	Description	—	—	—	—	—	—	<table border="1"> <thead> <tr> <th>Ref. No.</th> <th>Part No.</th> <th>Description</th> <th>QTY</th> </tr> </thead> <tbody> <tr> <td>Q702</td> <td>8-729-054-52</td> <td>TRANSISTOR</td> <td>UP04216008SO</td> </tr> <tr> <td>R146</td> <td>1-216-864-11</td> <td>SHORT CHIP</td> <td>0</td> </tr> <tr> <td>R149</td> <td>1-216-864-11</td> <td>SHORT CHIP</td> <td>0</td> </tr> </tbody> </table>	Ref. No.	Part No.	Description	QTY	Q702	8-729-054-52	TRANSISTOR	UP04216008SO	R146	1-216-864-11	SHORT CHIP	0	R149	1-216-864-11	SHORT CHIP	0
	Ref. No.	Part No.	Description																								
—	—	—																									
—	—	—																									
Ref. No.	Part No.	Description	QTY																								
Q702	8-729-054-52	TRANSISTOR	UP04216008SO																								
R146	1-216-864-11	SHORT CHIP	0																								
R149	1-216-864-11	SHORT CHIP	0																								
5-15	<table border="1"> <tbody> <tr><td>—</td><td>—</td><td>—</td></tr> <tr><td>—</td><td>—</td><td>—</td></tr> </tbody> </table>	—	—	—	—	—	—	<table border="1"> <tbody> <tr> <td>R307</td> <td>1-218-990-11</td> <td>SHORT CHIP</td> <td>0</td> </tr> <tr> <td>R751</td> <td>1-218-977-11</td> <td>RES-CHIP</td> <td>100K 5% 1/16W</td> </tr> <tr> <td>R752</td> <td>1-218-945-11</td> <td>RES-CHIP</td> <td>220 5% 1/16W</td> </tr> </tbody> </table>	R307	1-218-990-11	SHORT CHIP	0	R751	1-218-977-11	RES-CHIP	100K 5% 1/16W	R752	1-218-945-11	RES-CHIP	220 5% 1/16W							
—	—	—																									
—	—	—																									
R307	1-218-990-11	SHORT CHIP	0																								
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R752	1-218-945-11	RES-CHIP	220 5% 1/16W																								

**[Description of main button functions on toolbar of the Adobe Acrobat Reader Ver5.0 (for Windows)]**




Toolbar



**Printing a text**

1. Click the Print button .
2. Specify a printer, print range, number of copies, and other options, and then click [OK].

**Application of printing:**

To set a range to be printed within a page, select the graphic selection tool  and drag on the page to enclose a range to be printed, and then click the Print button.


**Reversing the screens displayed once**

- To reverse the previous screens (operation) one by one, click the .
- To advance the reversed screens (operation) one by one, click the .

**Application to the Service Manual:**

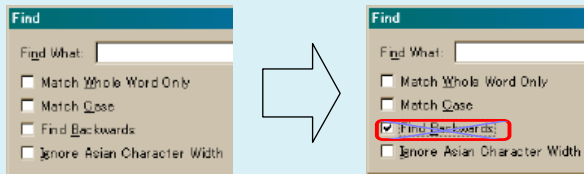
This function allows you to go and back between circuit diagram and printed circuit board diagram, and accordingly it will be convenient for the voltage check.

**Finding a text**

1. Click the Find button .
2. Enter a character string to be found into a text box, and click the [Find]. (Specify the find options as necessary)

**Application to the Service Manual:**

To execute “find” from current page toward the previous pages, select the check box “Find Backwards” and then click the “Find”.








3. Open the find dialog box again, and click the [Find Again] and you can find the matched character strings displayed next. (Character strings entered previously are displayed as they are in the text box.)

**Application to the Service Manual:**


The parts on the drawing pages (block diagrams, circuit diagrams, printed circuit boards) and parts list pages in a text can be found using this find function. For example, find a Ref. No. of IC on the block diagram, and click the [Find Again] continuously, so that you can move to the Ref. No. of IC on the circuit diagram or printed circuit board diagram successively.


**Note:** The find function may not be applied to the Service Manual depending on the date of issue.

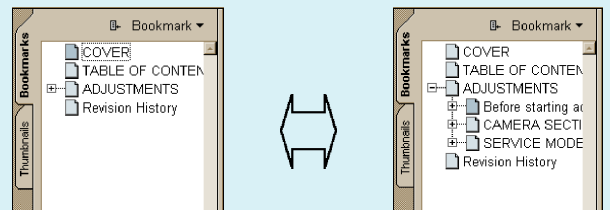
**Moving with link**

1. Select either palm tool , zoom tool , text selection tool , or graphic selection tool .
2. Place the pointer in the position in a text where the link exists (such as a button on cover and the table of contents page, or blue characters on the removal flowchart page or drawing page), and the pointer will change to the forefinger form .
3. Then, click the link. (You will go to the link destination.)

**Moving with bookmark:**



Click an item (text) on the bookmark pallet. and you can move to the link destination. Also, clicking  can display the hidden items.

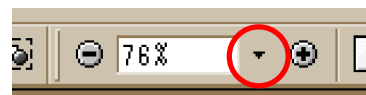
(To go back to original state, click )




**Zooming or rotating the screen display**

**“Zoom in/out”**

- Click the triangle button in the zoom control box to select the display magnification. Or, you may click  or  for zooming in or out.







**“Rotate”**

- Click rotate tool , and the page then rotates 90 degrees each.

**Application to the Service Manual:**

The printed circuit board diagram you see now can be changed to the same direction as the set.

**Switching a page**

- To move to the first page, click the .
- To move to the last page, click the .
- To move to the previous page, click the .
- To move to the next page, click the .

## Revision History

Ver.	Date	History	Contents	S.M. Rev. issued
1.0	2006.02	Official Release	—	—
1.1	2006.07	<a href="#">Supplement-1</a> (DI06-030)	<ul style="list-style-type: none"> <li>Addition of formatting procedure after replacement of IC202</li> </ul> S.M. correction: Page <a href="#">4-29</a> , <a href="#">5-14</a>	Yes
1.2	2006.10	Correction-1	<ul style="list-style-type: none"> <li>Correction of printed wiring boards</li> </ul> S.M. correction: Page <a href="#">4-52</a> , <a href="#">4-54</a>	Yes
1.3	2006.10	<a href="#">Supplement-2</a> (DI06-116)	<ul style="list-style-type: none"> <li>Change of boards suffix number (SY-150)</li> <li>Change of repair parts list</li> </ul>	No